EECS 151/251A

Spring 2018

Digital Design and Integrated Circuits

Instructors:

N. Weaver & J. Wawrzynek

Lecture 2

Class Schedule - UPDATE

- Discussions: Friday 11am-12, 106 Moffit Library
- LAB A (ASIC):
  - W 5-8pm (125 Cory) - Taehwan
- LAB B (FPGA):
  - W 2-5pm (125 Cory) - Arya
  - Th 2-5pm (125 Cory) - Arya
- Office Hours:
  - Nick : Mo 1-3pm - 329 Soda
  - John : Tu, Th 2:30pm-3:30pm - 631 Soda
  - Taehwan: TBD
  - Arya: TBD
- Homework out today, due: next Friday at 11:59PM

Schedule for this week

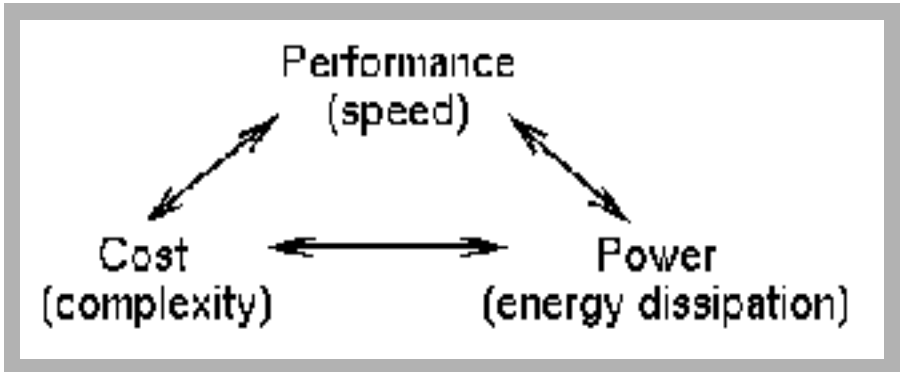
- First discussion this Friday
- Labs starting this week

Outline

- Methodology Basics
- Digital Logic – Basic Concepts
- Early Design
- Design Implementation Alternatives
- Design Flows
- ASICs
- FPGAs

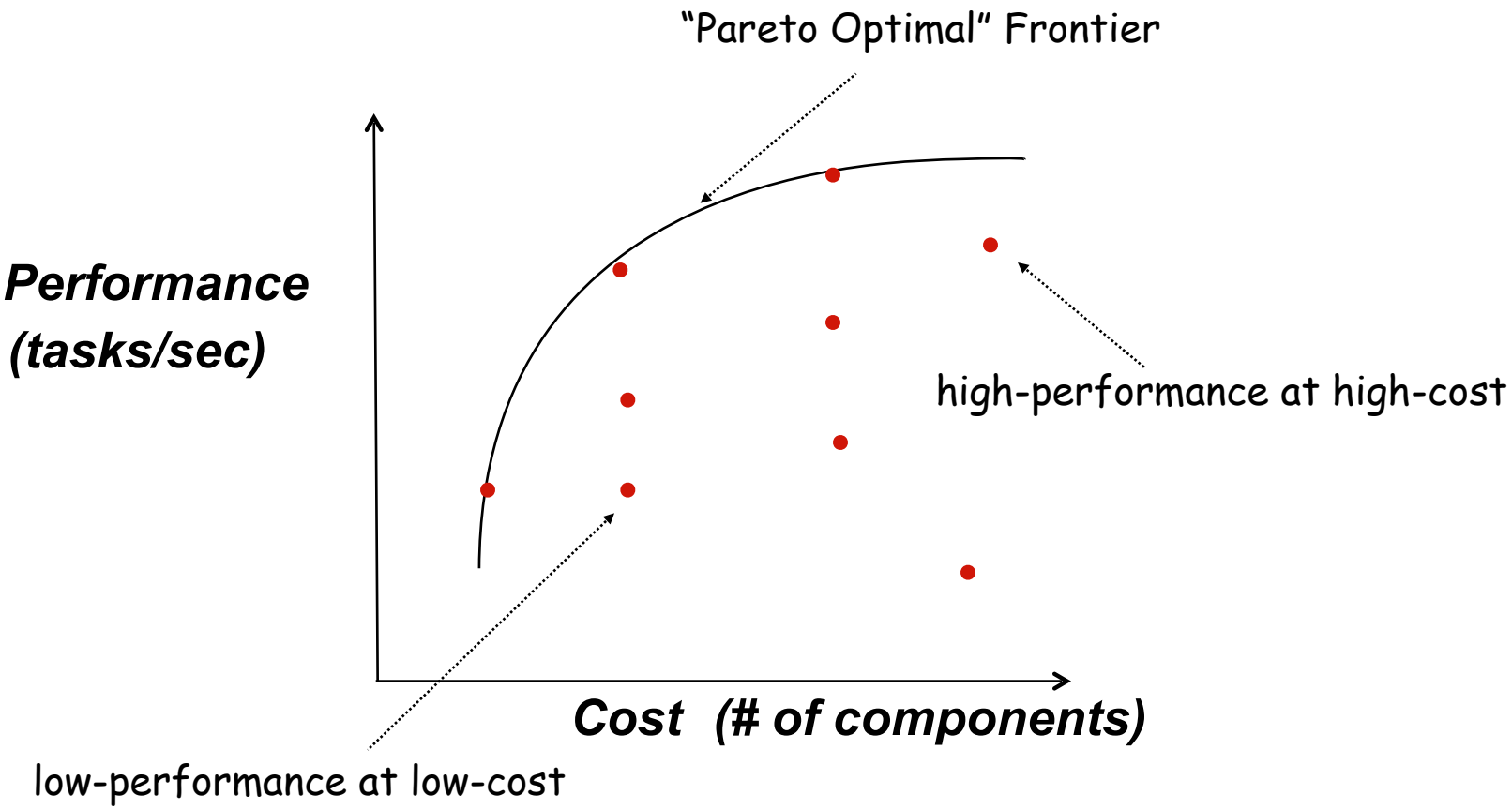
Methodology Basics

Basic Design Tradeoffs



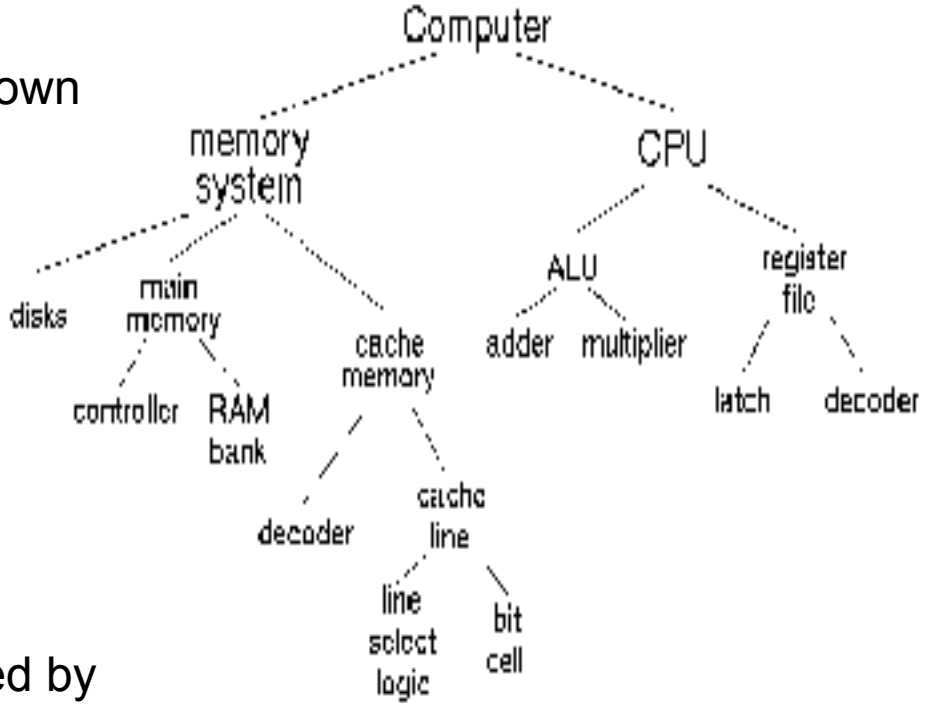
- Improve on one at the expense of the others
- Tradeoffs exist at every level in the system design
- Design Specification
  - Functional Description
  - Performance, cost, power constraints
- Designer must make the tradeoffs needed to achieve the function within the constraints

Design Space & Optimality



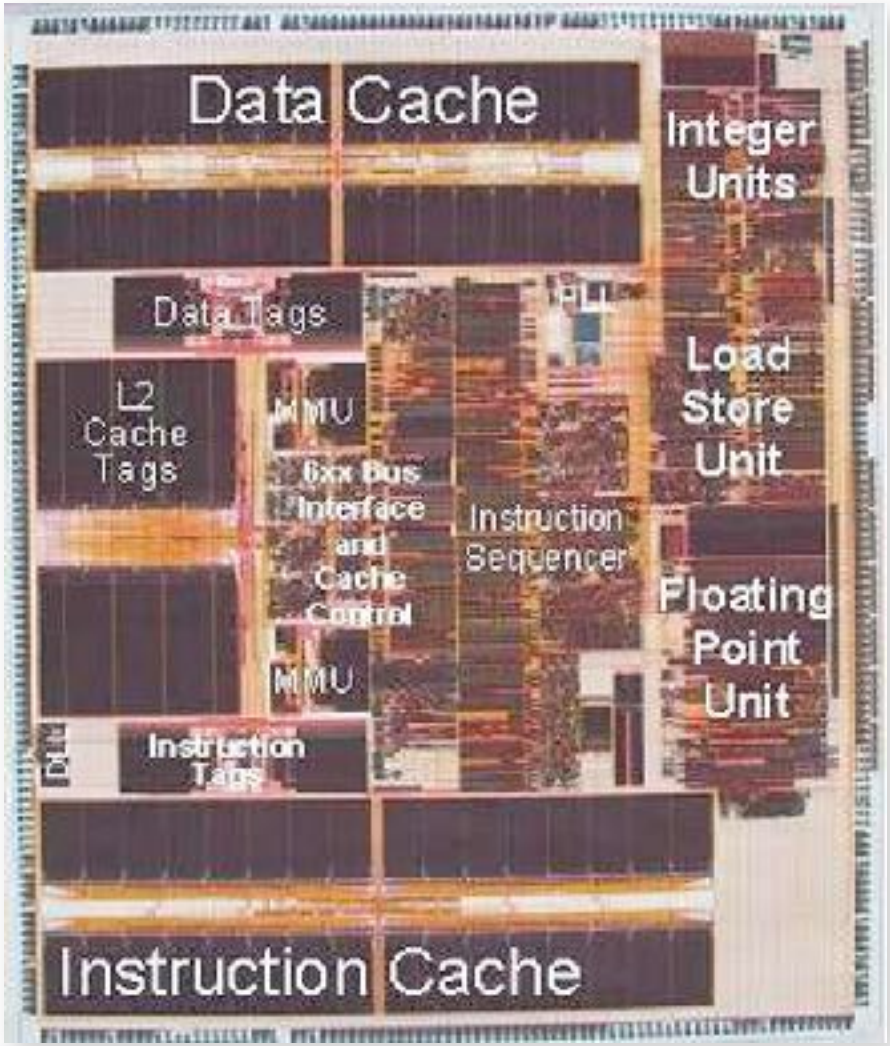
Design Methodologies

- Top-Down Design
  - Starts at the top (root) and works down by successive refinement.
- Bottom-up Design
  - Starts at the leaves & puts pieces together to build up the design.
- Which is better?
  - In practice both are needed & used
  - Top-down to handle the complexity (divide and conquer)
  - Bottom-up since structure influenced by available primitives (in a well designed system)



Digital Logic
Basic Concepts

Digital Integrated Circuit Example

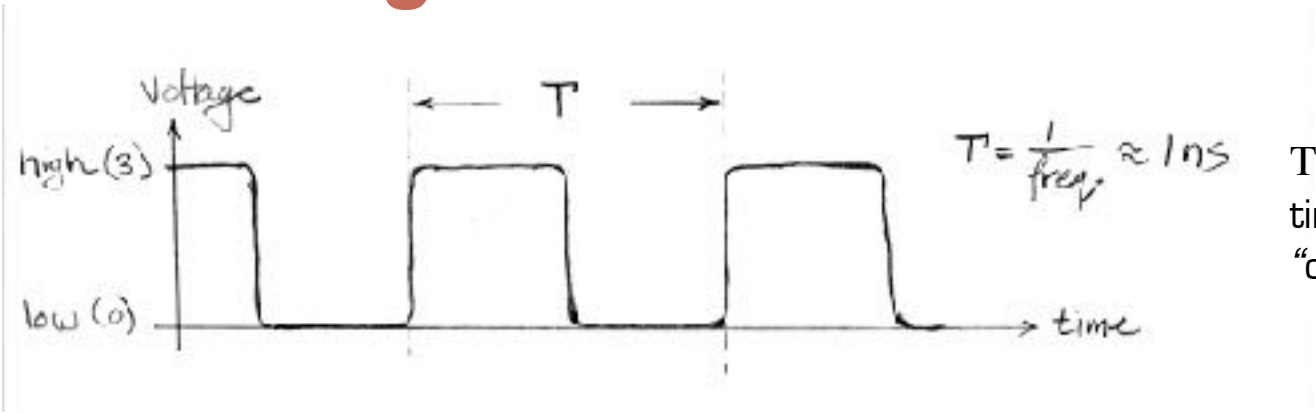


- (Old) PowerPC microprocessor micro-photograph
  - Superscalar (3 instructions/cycle)
  - 6 execution units (2 integer and 1 double precision IEEE floating point)
  - 32 KByte Instruction and Data L1 caches
  - Dual Memory Management Units (MMU)
  - External L2 Cache interface with integrated controller and cache tags.

Comprises only transistors and wires.

Connections to outside world (ex. motherboard)
- Memory interface
- Power (Vdd, GND)
- Clock input

Clock Signal



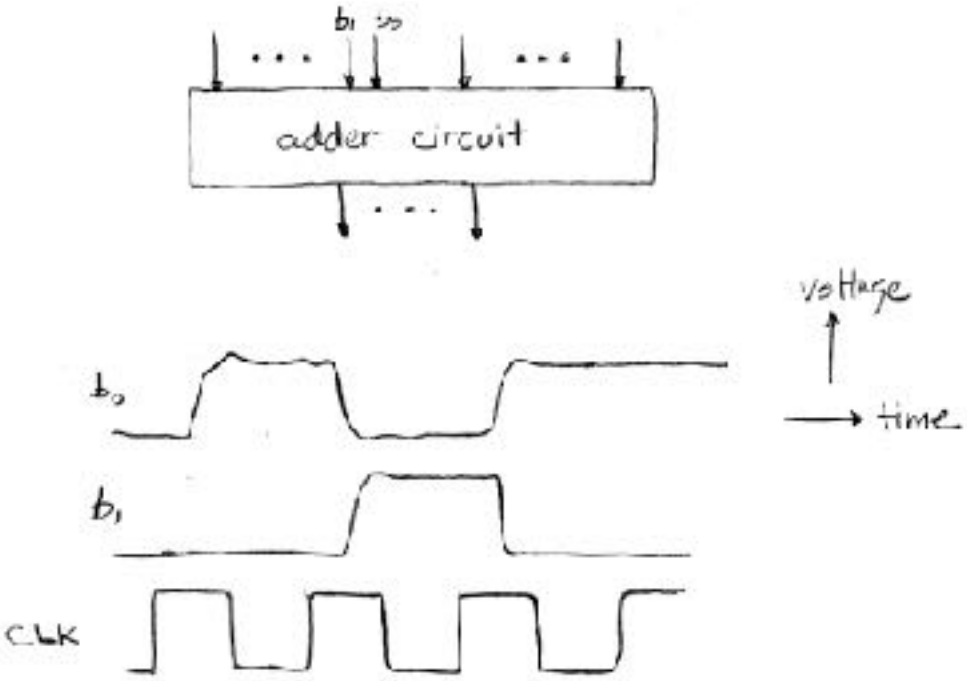
T represents the time of one clock "cycle".

A source of regularly occurring pulses used to measure the passage of time.

- Waveform diagram shows evolution of signal value (in voltage) over time.

- Usually comes from an off-chip crystal-controlled oscillator.
- One main clock per chip/system.
- Distributed throughout the chip/system.
- "Heartbeat" of the system. Controls the rate of computation by directly controlling all data transfers.

Data Signals



Random adder circuit at a random point in time:

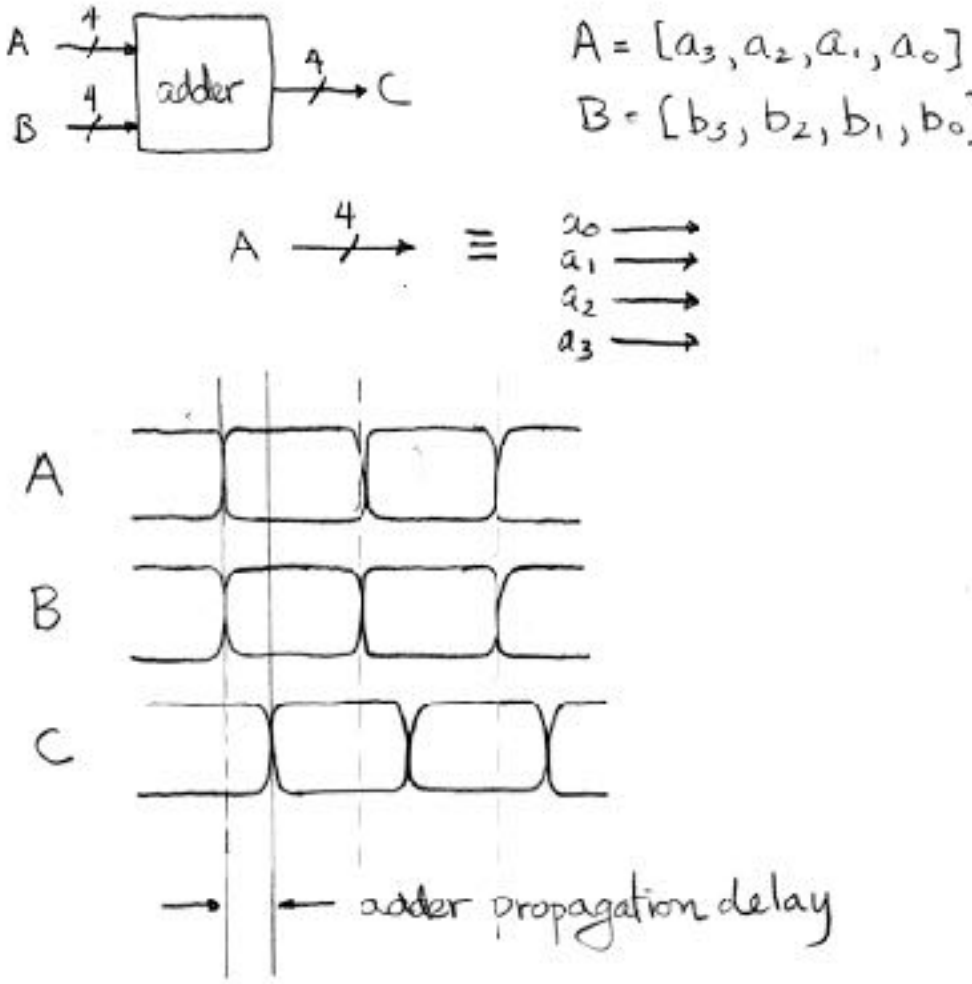
Observations:

- Most of the time, signals are in either low- or high-voltage position.
- When the signals are at the high- or low-voltage positions, they are not all the way to the voltage extremes (or they are past).
- Changes in the signals correspond to changes in clock signal (but don't change every cycle).

The facts:

1. Low-voltage represents binary 0 and high-voltage, binary 1.
2. Circuits are designed and built to be tolerant of noise and "restoring". Deviations from ideal voltages are ignored. Outputs close to ideal.
3. In synchronous systems, all changes follow clock edges.

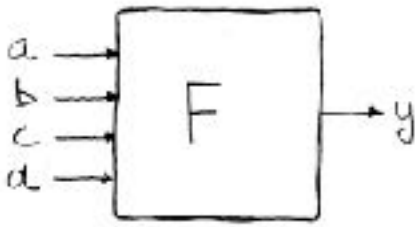
Circuit Delay



- Digital circuits cannot produce outputs instantaneously.
- In general, the delay through a circuit is called the propagation delay. It measures the time from when inputs arrive until the outputs change.
- The delay amount is a function of many things. Some out of the control of the circuit designer:
  - Processing technology, the particular input values.
- And others under her control:
  - Circuit structure, physical layout parameters.

Combinational Logic Blocks

Example four-input function:



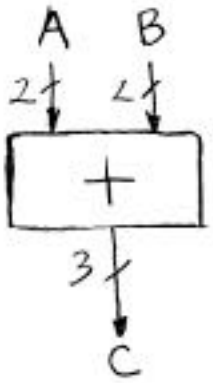
a b c d	y
0 0 0 0	F(0,0,0,0)
0 0 0 1	F(0,0,0,1)
0 0 1 0	F(0,0,1,0)
0 0 1 1	F(0,0,1,1)
0 1 0 0	F(0,1,0,0)
0 1 0 1	F(0,1,0,1)
0 1 1 0	F(0,1,1,0)
1 1 1 1	F(0,1,1,1)
1 0 0 0	F(1,0,0,0)
1 0 0 1	F(1,0,0,1)
1 0 1 0	F(1,0,1,0)
1 0 1 1	F(1,0,1,1)
1 1 0 0	F(1,1,0,0)
1 1 0 1	F(1,1,0,1)
1 1 1 0	F(1,1,1,0)
1 1 1 1	F(1,1,1,1)

Truth Table

- Output a function only of the current inputs (no history).
- Truth-table representation of function. Output is explicitly specified for each input combination.
- In general, CL blocks have more than one output signal, in which case, the truth-table will have multiple output columns.

Example CL Block

- 2-bit adder. Takes two 2-bit integers and produces 3-bit result.



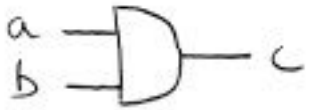
- Think about truth table for 32-bit adder. It's possible to write out, but it might take a while!

a1 a0	b1 b0	c2 c1 c0
00	00	000
00	01	001
00	10	010
00	11	011
01	00	001
01	01	010
01	10	011
01	11	100
10	00	010
10	01	011
10	10	100
10	11	101
11	00	011
11	01	100
11	10	101
11	11	110

Theorem: Any combinational logic function can be implemented as a networks of logic gates.

Logic Gates

AND



ab	c
00	0
01	0
10	0
11	1

OR

ab	c
00	0
01	1
10	1
11	1

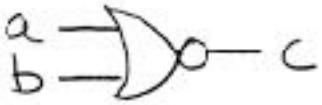
NOT

a	b
0	1
1	0

NAND

ab	c
00	1
01	1
10	1
11	0

NOR



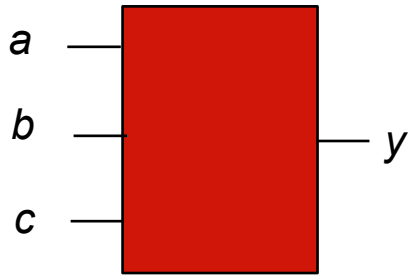
ab	c
00	1
01	0
10	0
11	0

XOR

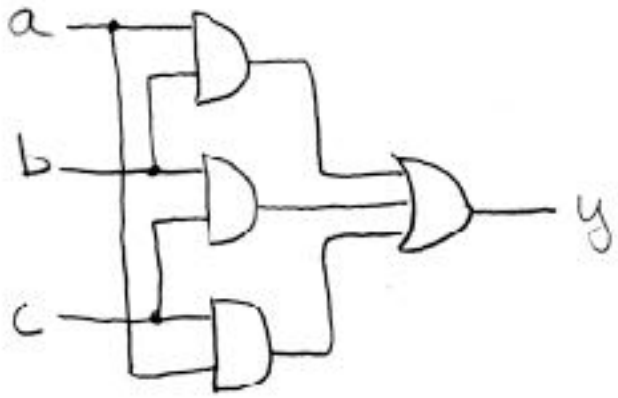
ab	c
00	0
01	1
10	1
11	0

- Logic gates are often the primitive elements out of which combinational logic circuits are constructed.
  - In some technologies, there is a one-to-one correspondence between logic gate representations and actual circuits (ASIC standard cells have gate implementations).
  - Other times, we use them just as another abstraction layer (FPGAs have no real logic gates).
- How about these gates with more than 2 inputs?
- Do we need all these types?

Example Logic Circuit



a	b	c	y
0	0	0	0
0	0	1	0
0	1	0	0
0	1	1	1
1	0	0	0
1	0	1	1
1	1	0	1
1	1	1	1

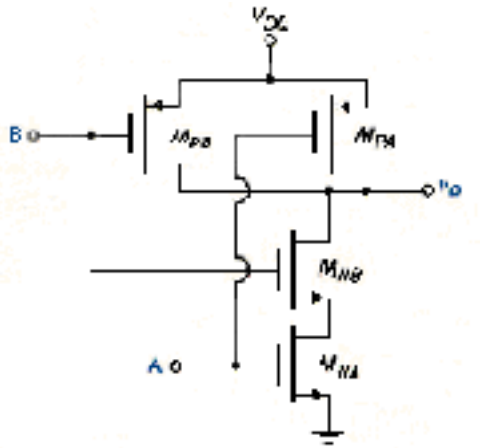


How do we know that these two representations are equivalent?

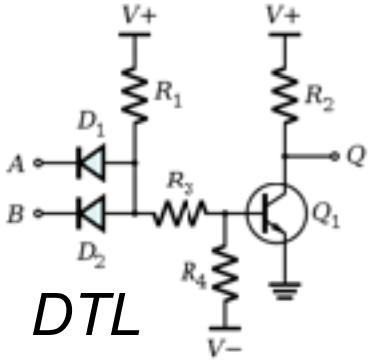
Will come back to this later!

Logic Gate Implementation

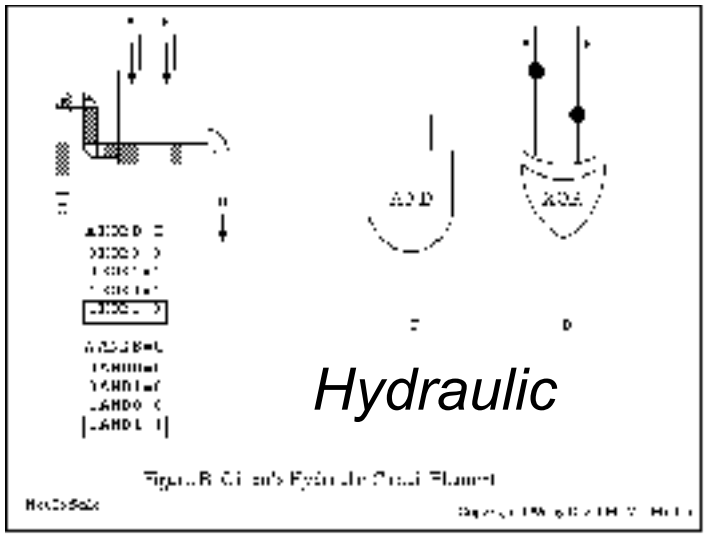
- Logic circuits have been built out of many different technologies. If we have a basic logic gate (AND or OR) and inversion we can build a complete logic family.



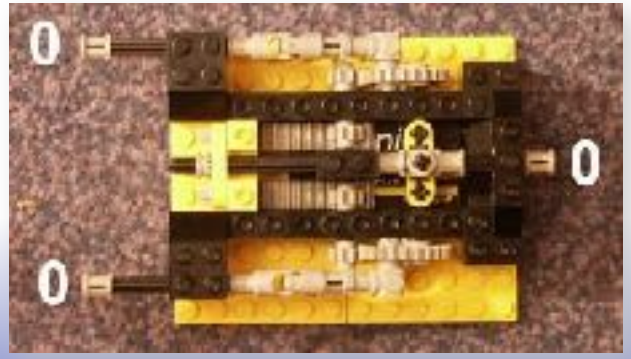
CMOS Gate



DTL



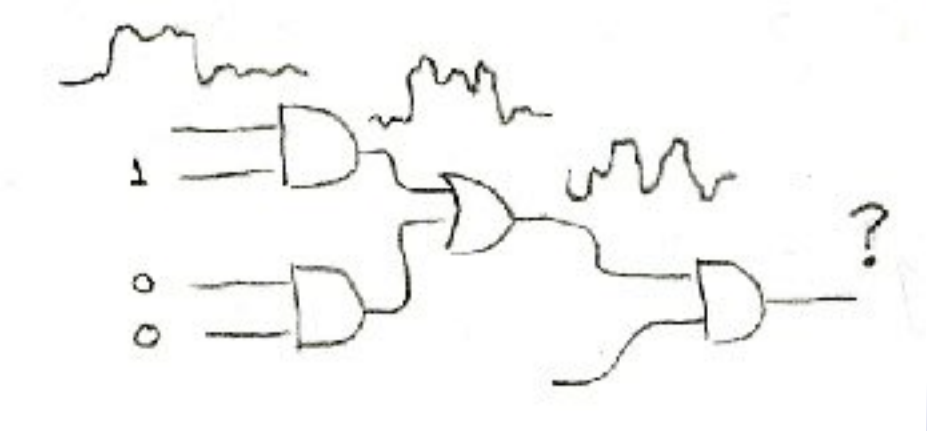
Hydraulic



Mechanical *LEGO logic gates. A clockwise rotation represents a binary "one" while a counter-clockwise rotation represents a binary "zero."*

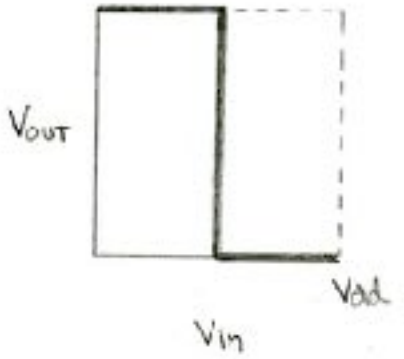
Restoration/Regeneration

- A necessary property of any suitable technology for logic circuits is "Restoration" or "Regeneration"
- Circuits need:
  - to ignore noise and other non-idealities at the their inputs, and
  - generate "cleaned-up" signals at their output.
- Otherwise, each stage propagates input noise to their output and eventually noise and other non-idealities would accumulate and signal content would be lost.

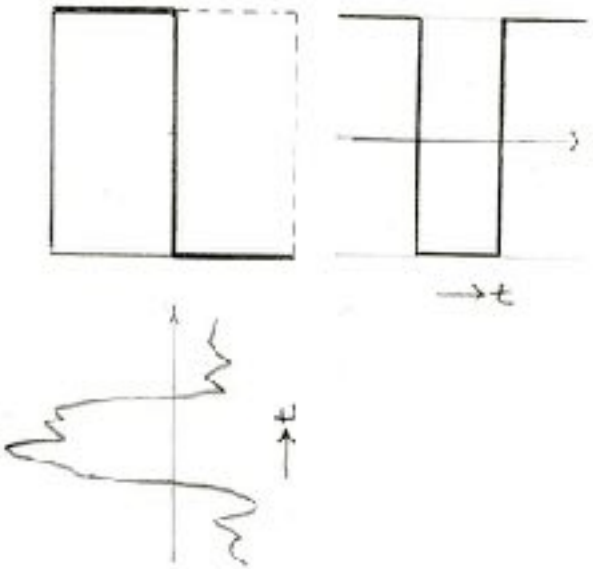


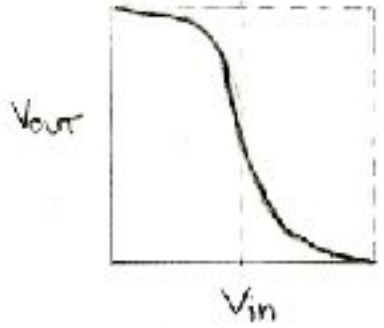
Inverter Example of Restoration

Example (look at 1-input gate, to keep it simple):



Idealize Inverter



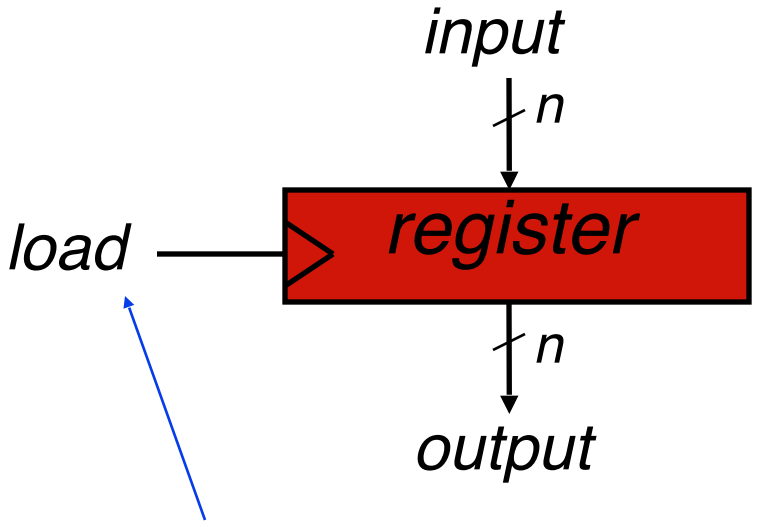


Actual Inverter

- Inverter acts like a “non-linear” amplifier
- The non-linearity is critical to restoration
- Other logic gates act similarly with respect to input/output relationship.

State Elements: circuits that store info

- Examples: registers, memories
- Register: Under the control of the "load" signal, the register captures the input value and stores it indefinitely.

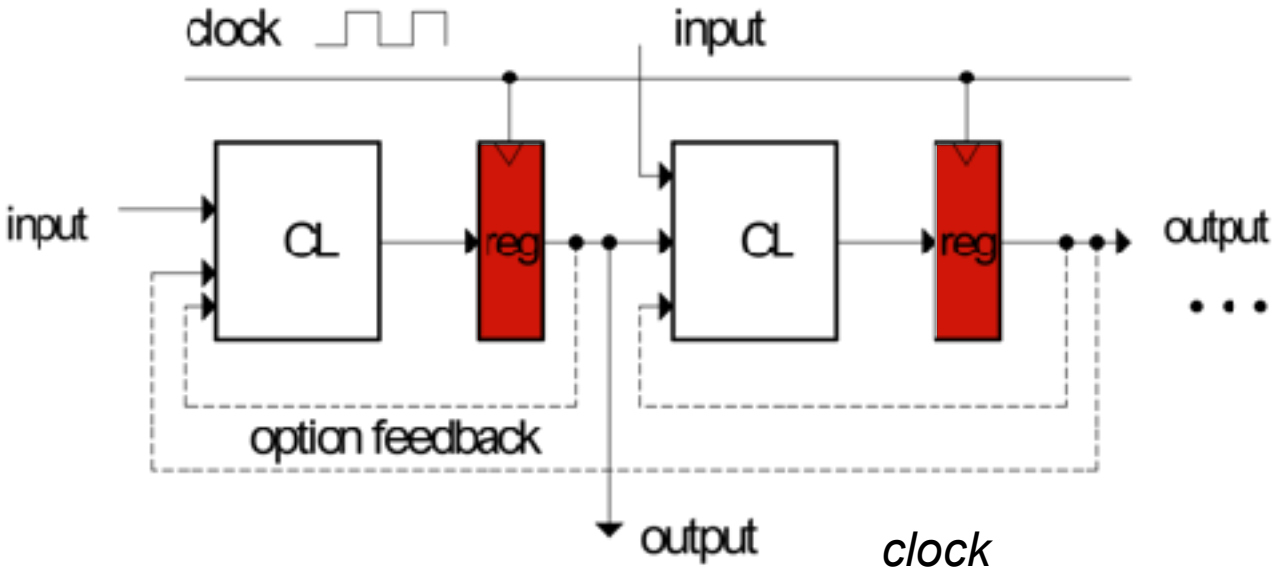


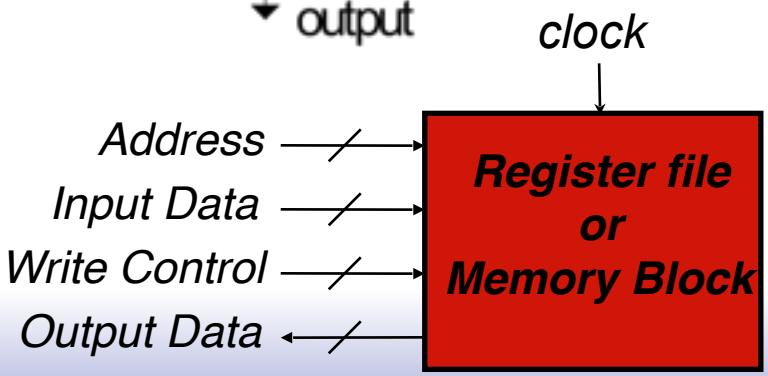
- The value stored by the register appears on the output (after a small delay).
- Until the next load, changes on the data input are ignored (unlike CL, where input changes change output).
- These get used for short term storage (ex: register file), and to help move coordinate data movement.

Register Transfer Level Abstraction (RTL)

Any synchronous digital circuit can be represented with:

- Combinational Logic Blocks (CL), plus
- State Elements (registers or memories)



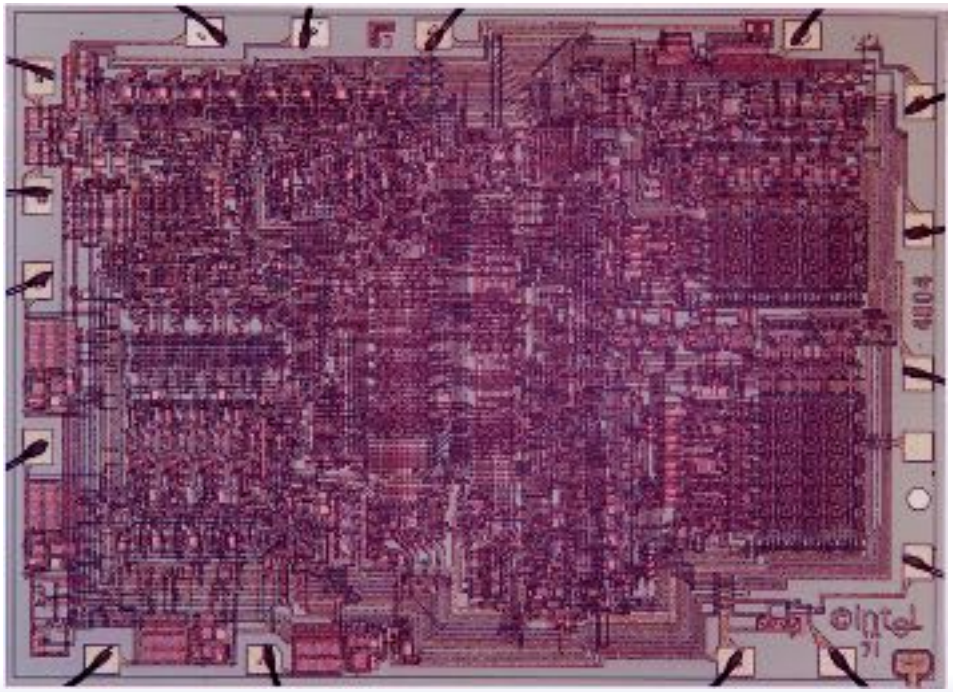


- State elements are mixed in with CL blocks to control the flow of data.
- Sometimes used in large groups by themselves for "long-term" data storage.

Early Design

IC Design in the 70's and early 80's

- Circuit design, layout, and processing tightly linked.
- Logic design and layout was all done by-hand in an ad-hoc way
- Chip design was the domain of industry (Fairchild, Intel, Texas Instruments, …). These were IC processing companies. Those who controlled the physics controlled the creative agenda!



Federico Faggin,
Ted Hoff,
Stan Mazor

Introduced to help sell memory chips!

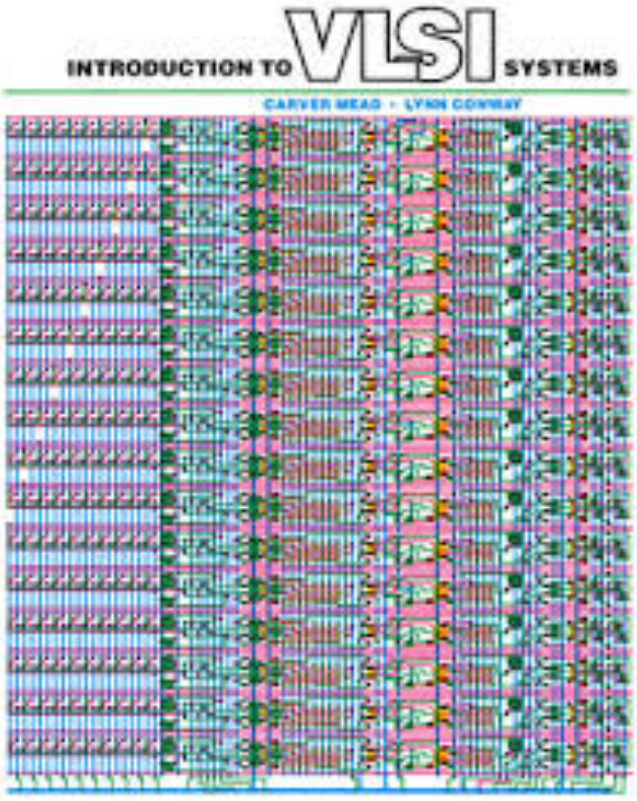
The Intel 4004 microprocessor, which was introduced in 1971. The 4004 contained 2300 transistors and performed 60,000 calculations per second. Courtesy: Intel.

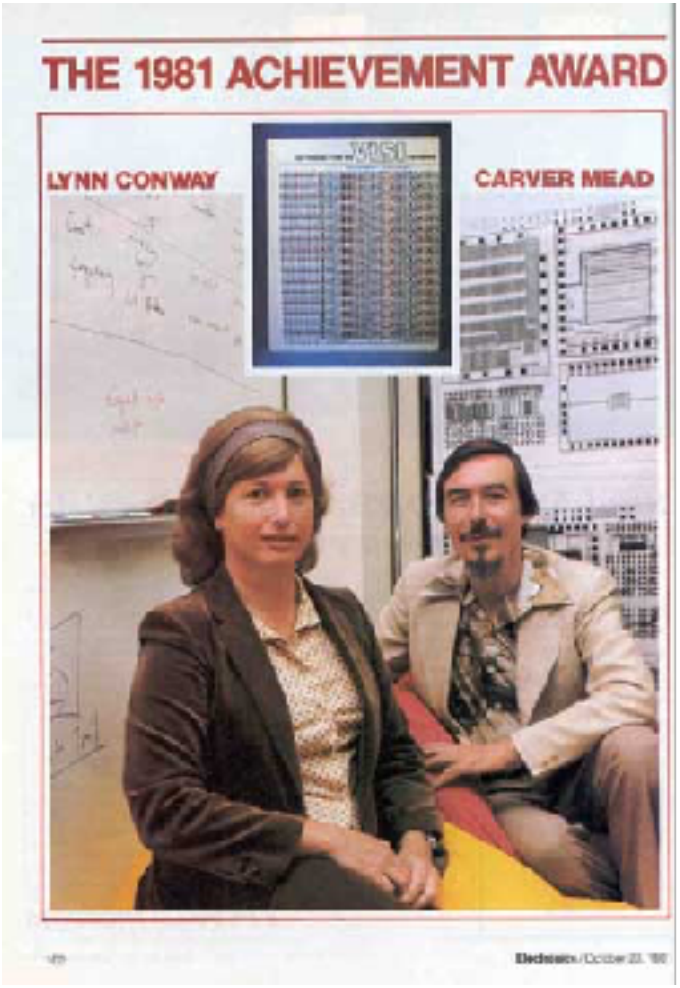
Early Design Practice

- Initially, designs were represented by hand drawings. Then masks where made by transferring drawings to rubylith.
  - Base layer of heavy transparent dimensionally stable Mylar. A thin film of deep red cellophane-like material covers the base layer. Patterns formed by cutting (often by hand) the transparent covering.

- *Later transition to an electronic format (CIF, GDS) meant:*
  Layouts easily be stored and transmitted. Written to tape and transferred to manufacturer (tape-out)*.Transmitted over the network (new idea back then). Software could automatically check for layout errors. Generated from a program -* ***huge idea.***

The start of the IC Design Revolution

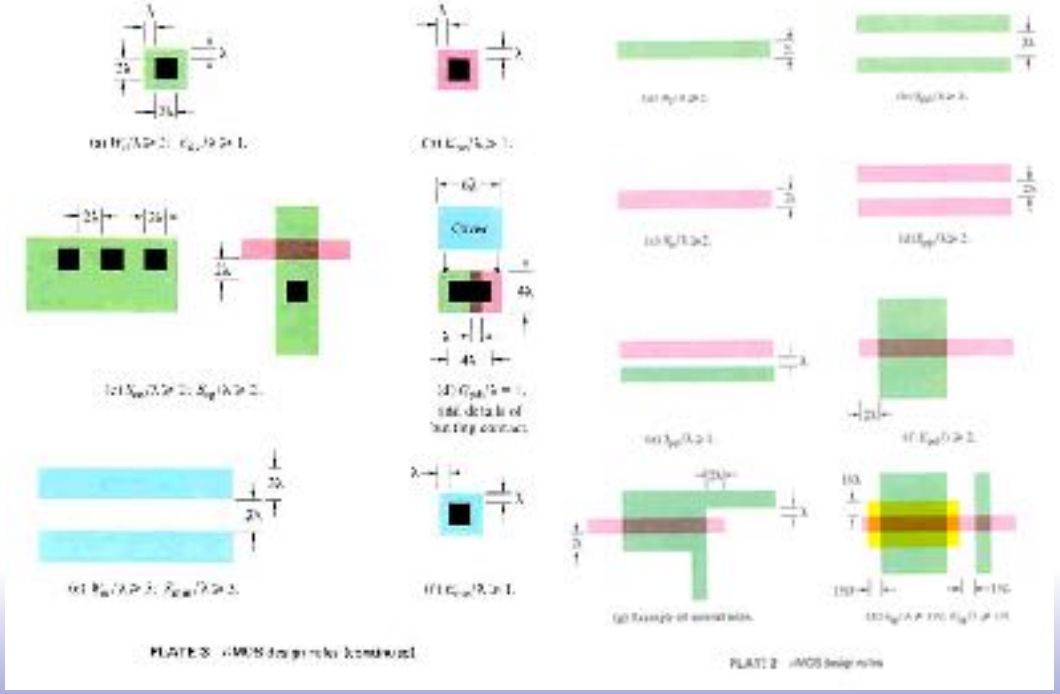




Geometric Design Rules

- Early on, to generate the mask information for fabrication, the designer needed intimate knowledge of the manufacturing process. Even once this knowledge was distilled to a set of “Geometric Design Rules”, this set of rules was voluminous with many special cases.
- Academics (C. Mead and others) came up with a much simplified set of design rules (single page description). A sort of “API” or abstraction of the process (back-end processing could automatically convert this information into masks).

  - *Sufficiently small set that designers could memorize. Sufficiently abstract to allow process engineers to shrink the process and preserve existing layouts. Process resolution becomes a “parameter”, **λ**.*



Key Development: Silicon Foundries

- Separate the designer from the fabricator: Modeled after the printing industry. (Very few authors actually own and run printing presses!)
- Simple standard geometric design rules where the key: these form the "contract" between the designer and manufacturer.
- Designer sends the layout (in CIF format), foundry manufactures the chip and send back. Designer promises not to violate the design rules. Foundry promises to accurately follow layout.

- *A scalable model for the industry:*
  IC fab is expensive and complex. Amortizes the expense over many designers (batch processing with deep queues help). Designers and companies not held back by need to develop and maintain large expensive factories."fabless" semiconductor companies - lots of these and very few foundries.

TSMC, Global Foundries, UMC, Samsung, SMIC, …

Computer Aided Design (1)

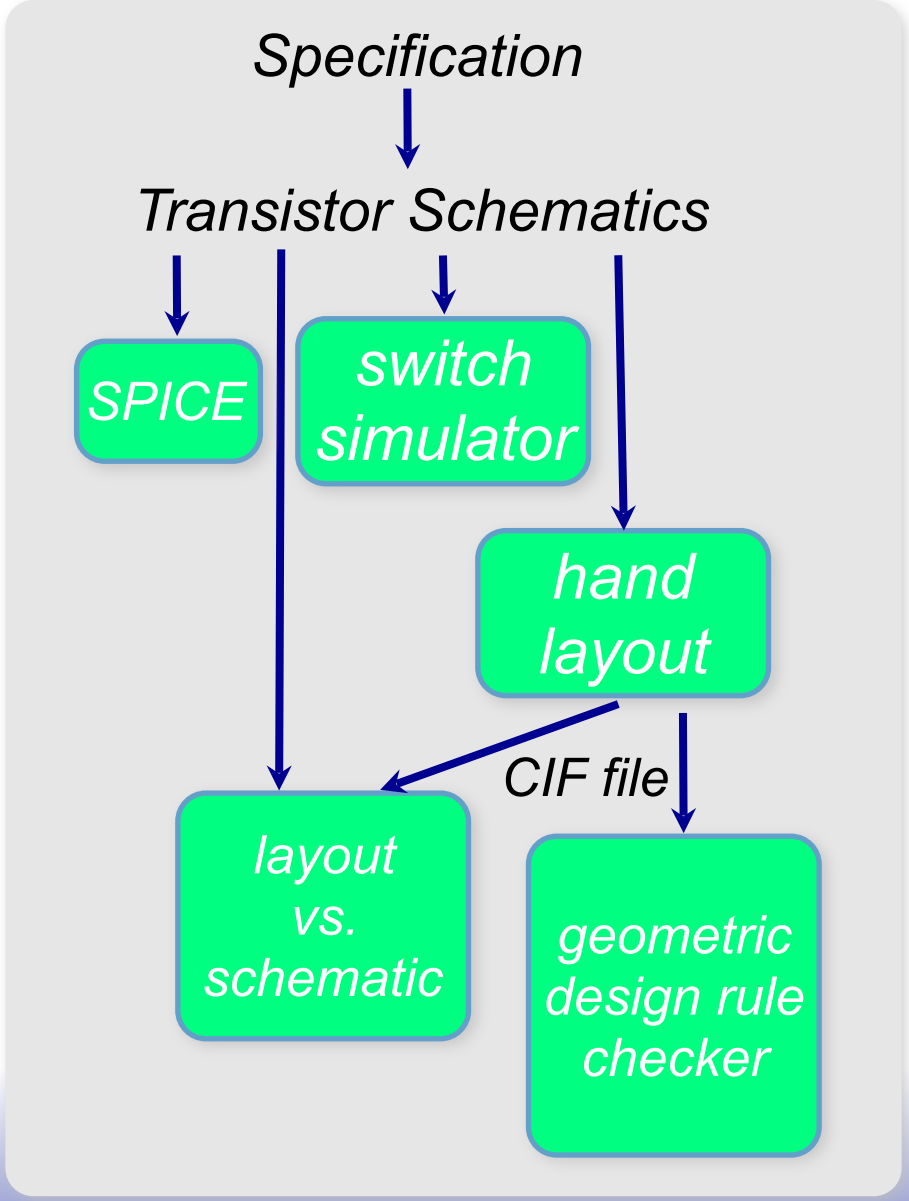
Several advances lead to the development of interactive tools for generating layout:

- Computer based layout representation (CIF, GDS).
- Advances in computer graphics (thanks to Ivan Sutherland and friends) and display devices.
- Personal “workstation” (Xerox Alto - Chuck Thacker). “Back room” computers didn’t have the necessary bandwidth to the display.
- Berkeley version - MAGIC

Early ’80’s Design Methodology and Flow

Schematic + Full-Custom Layout

- SPICE for timing,
- switch-level simulation for overall functionality,
- hand layout,
- no power analysis,
- layout verified with geometric Design Rule Checker (DRC) and later also Layout versus Schematic (LVS) Checkers



Computer Aided Design (2)

- For some time after CIF was invented: Layout was generated by hand, then typed in as a CIF file with a text editor.
- Layout compilers
  - Soon some designers started embedding CIF primitives in conventional programming languages: LISP, pascal, fortran, C.
  - This allows designers to write programs that generated layout. Such programs could be parameterized:

```
define GENERATE_RAM(rows, columns) {
  for I from 1 to rows
   for J from 1 to columns
     (GENERATE_BITCELL)}
GENERATE_RAM(128, 32);
```

  - *Lead to circuit/layout generation from higher level descriptions.*
- *Eventually, Cadence and Synopsys formed out of Berkeley.*

Implementation Alternatives & Design Flow

Implementation Alternative Summary

Full-custom:	All circuits/transistors layouts optimized for application.
Standard-cell:	Arrays of small function blocks (gates, FFs) automatically placed and routed.
Gate-array (structured ASIC):	Partially prefabricated wafers customized with metal layers or vias.
FPGA:	Prefabricated chips customized with loadable latches or fuses.
Microprocessor:	Instruction set interpreter customized through software.
Domain Specific Processor:	Special instruction set interpreters (ex: DSP, NP, GPU).

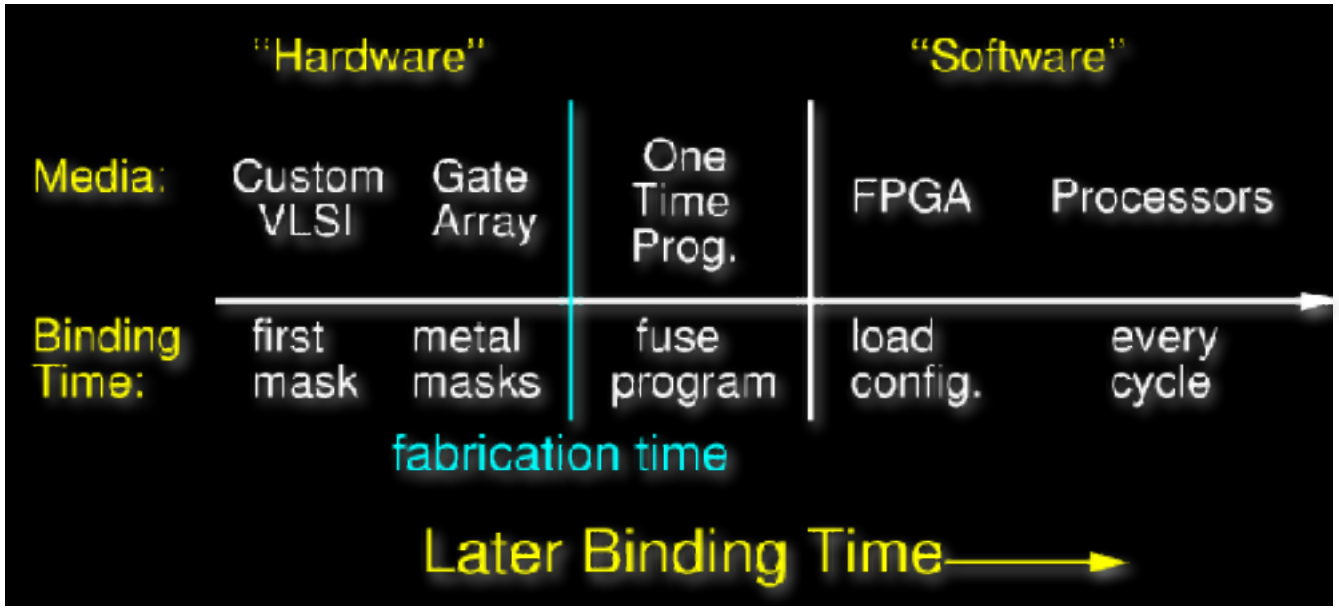
These days, "ASIC" almost always means Standard-cell.

What are the important metrics of comparison?

The Important Distinction

Instruction Binding Time

- *When* do we decide the functions (what operation is to be performed)?



A. DeHon

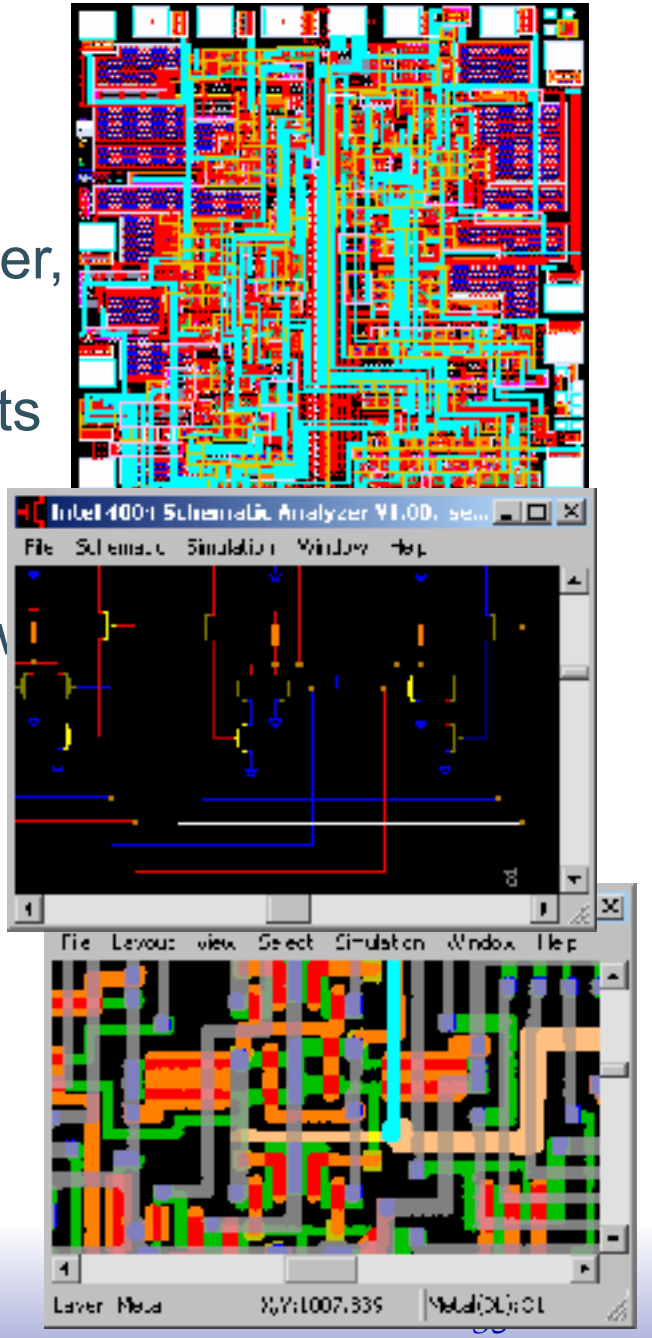
- ***General Principles***

Earlier the decision is bound, the less area, delay/energy required for the implementation.

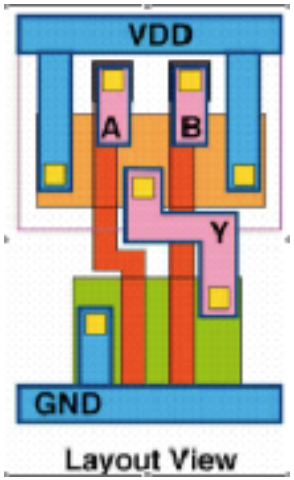
Later the decision is bound, the more flexible the device.

Full-Custom

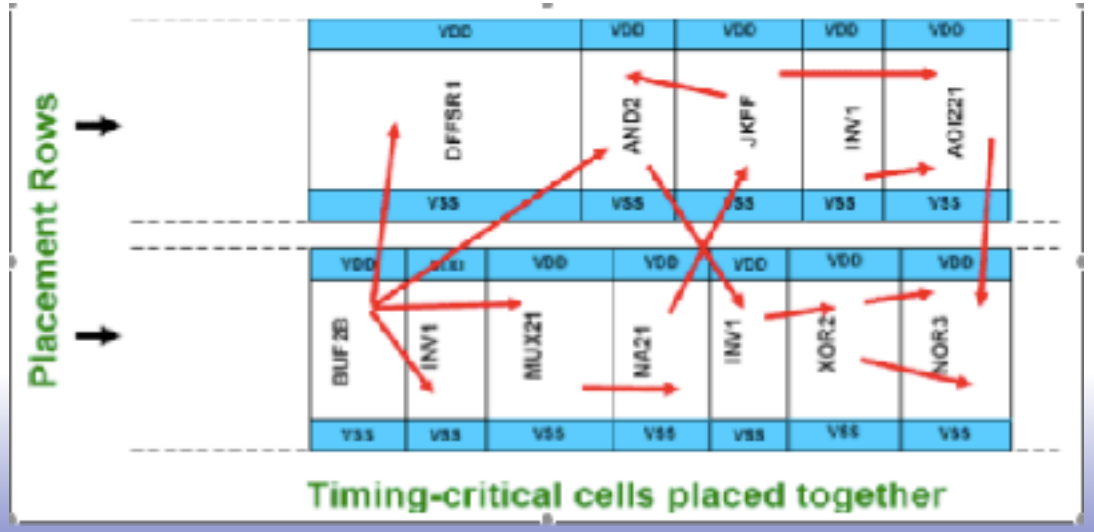
- Circuit styles and transistors are custom sized and drawn to optimize die, size, power, performance.
- High NRE (non-recurring engineering) costs
  - Time-consuming and error prone layout
- Hand-optimizing the layout can result in small die for low per unit costs, extreme-low power, or extreme-high-performance.
- Common today for **analog design**.
- Requires full set of custom masks.
- High NRE usually restricts use to high-volume applications/markets or highly-constrained and cost insensitive markets.

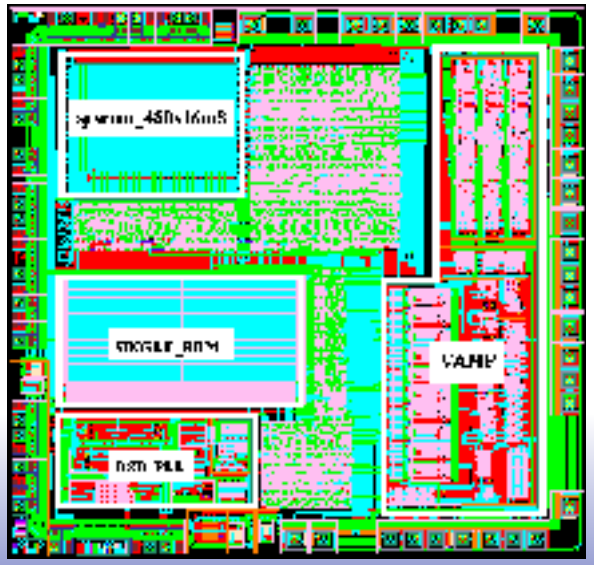


Standard-Cell*



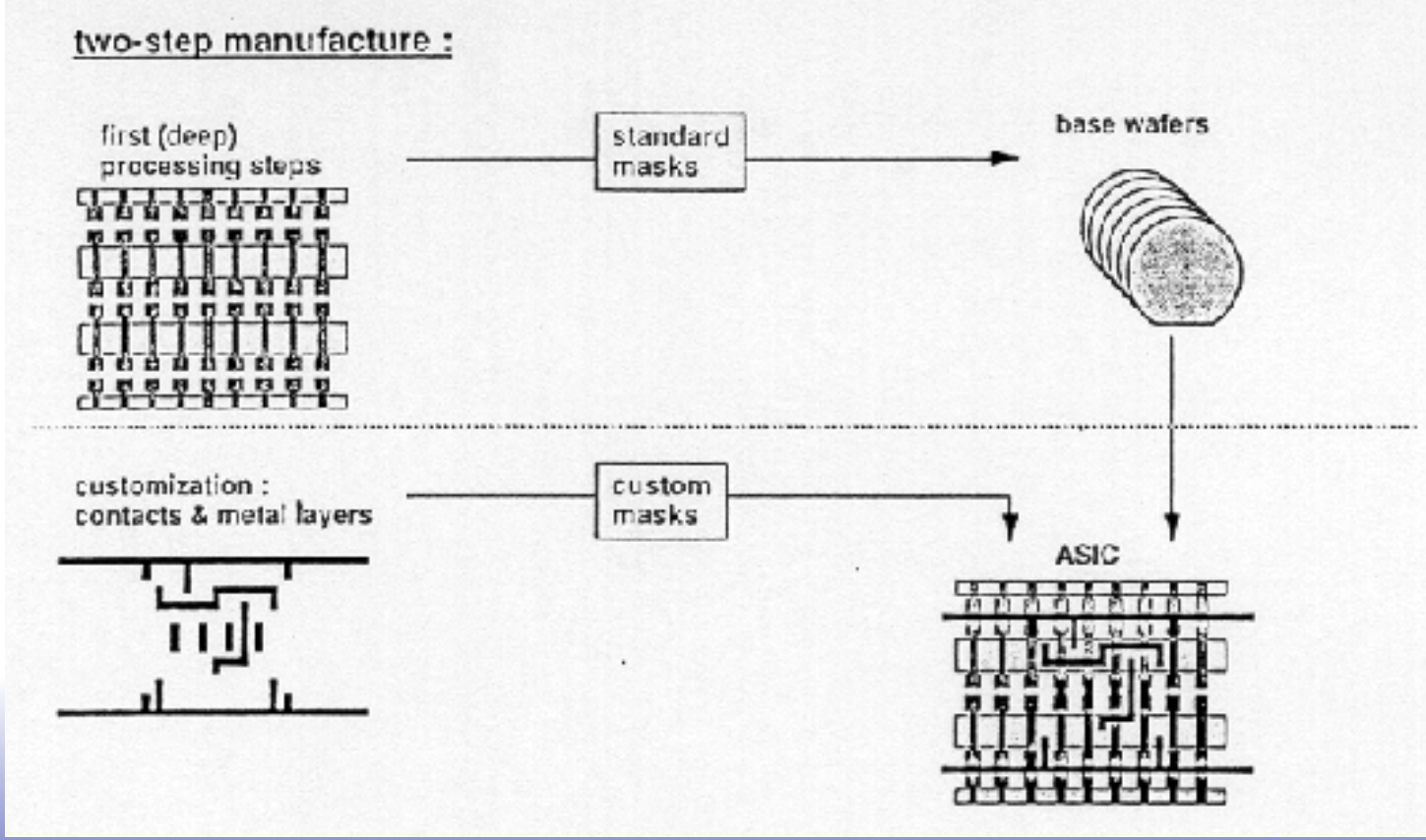
- Based around a set of pre-designed (and verified) cells
  - Ex: NANDs, NORs, Flip-Flops, counters slices, buffers, …
- Each cell comes complete with:
  - layout (perhaps for different technology nodes and processes),
  - Simulation, delay, & power models.
- Chip layout is automatic, reducing NREs (usually no hand-layout).
- Less optimal use of area and power, leading to higher per die costs than full-custom.
- Commonly used with other design implementation strategies (large blocks for memory, I/O blocks, etc.)





Gate Array

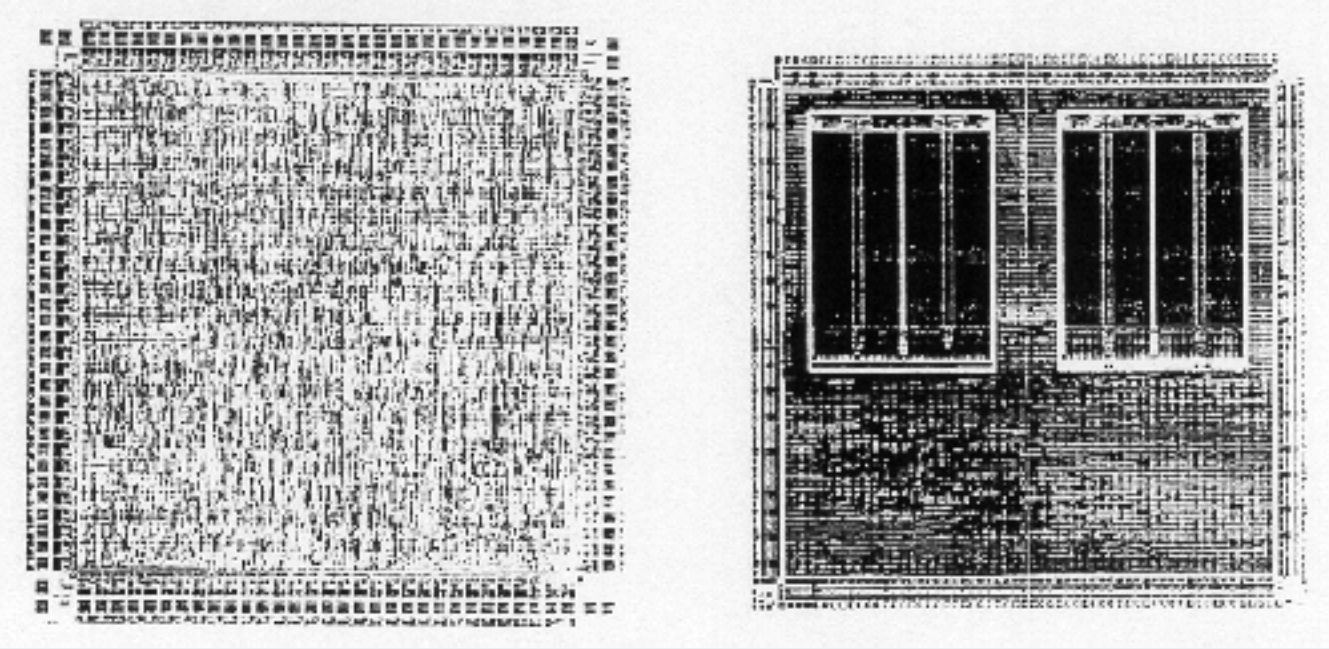
- Prefabricated wafers of “active” & gate layers & local interconnect, comprising, primarily, rows of transistors. Customize as needed with “back-end” metal processing (contact cuts, metal wires). Could use a different factory.
- CAD software understands how to make gates and registers.



Gate Array

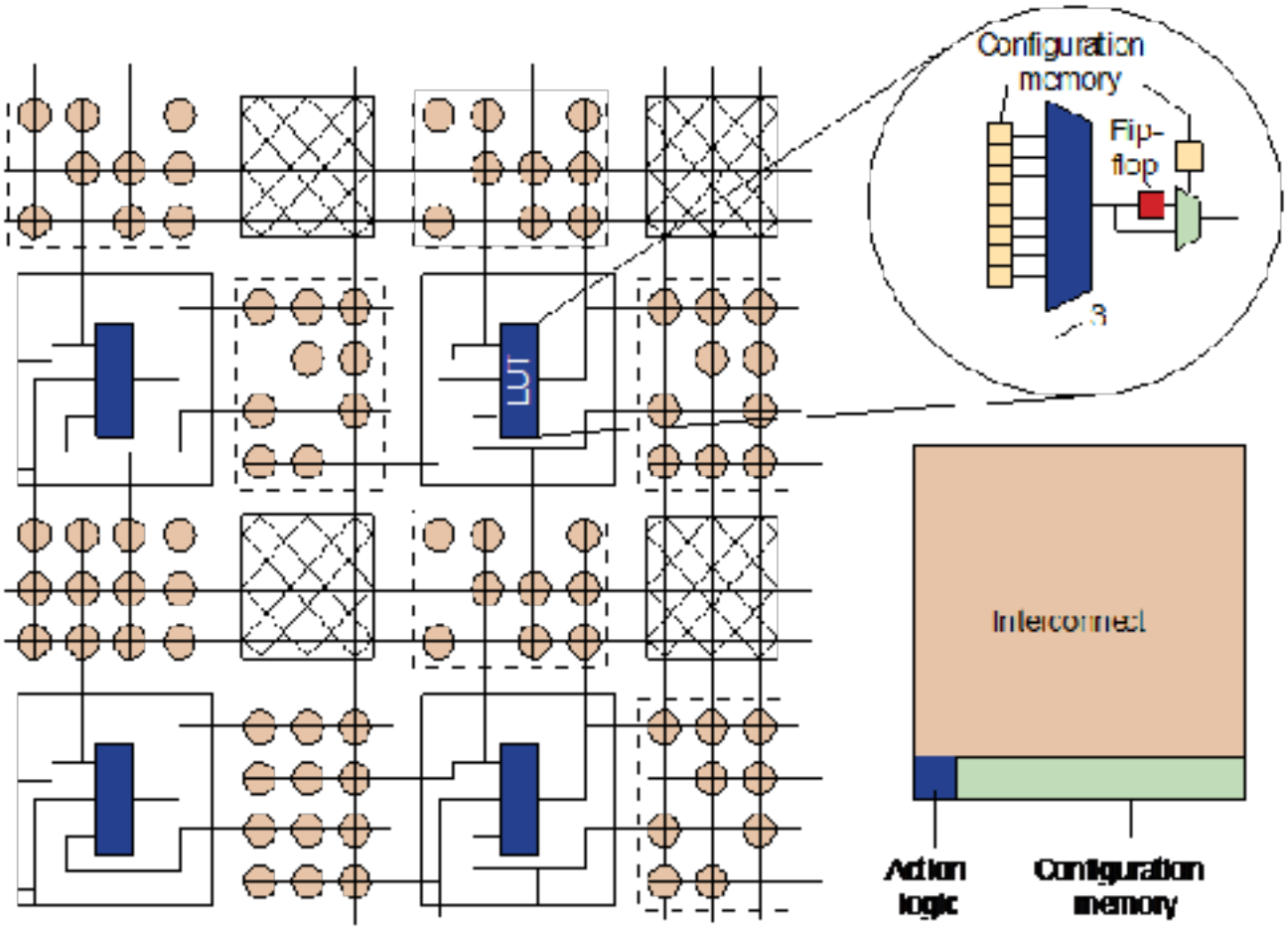
- *Shifts large portion of design and mask NRE to vendor.*
- *Shorter design and processing times, reduced time to market for user.*
- *Highly structured layout with fixed size transistors leads to large sub-circuits (ex: Flip-flops) and higher per die costs.*
- *Memory arrays are particularly inefficient, so often prefabricated, also:*

Sea-of-gates, structured ASIC, master-slice.



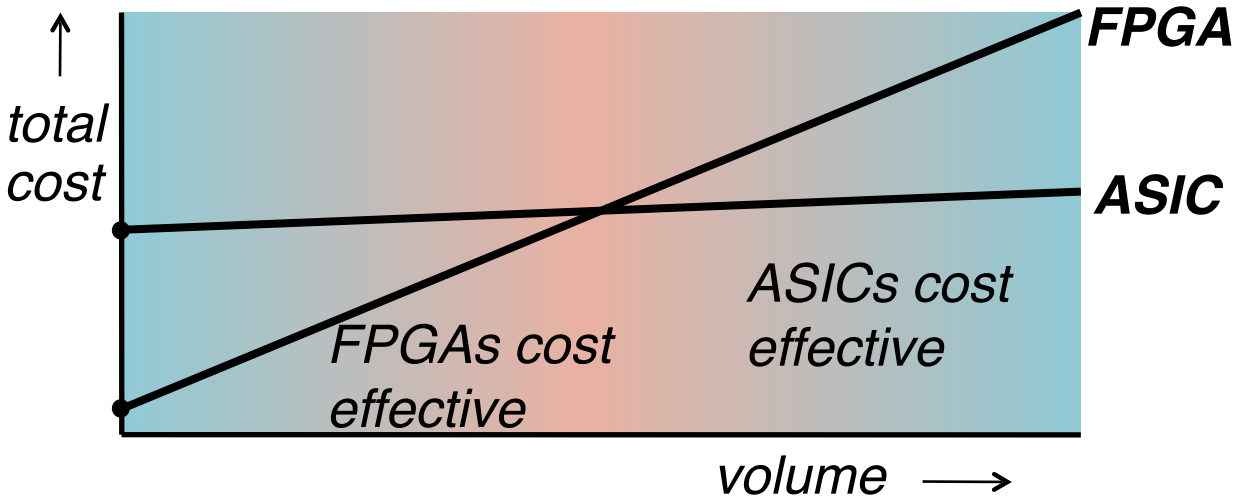
Field Programmable Gate Arrays (FPGA)

- *Two-dimensional array of simple logic- and interconnection-blocks.*
- *Typical architecture: Look-up-tables (LUTs) implement any function of n-inputs (n=3 in this case).*
- *Optional connected Flip-flop with each LUT.*



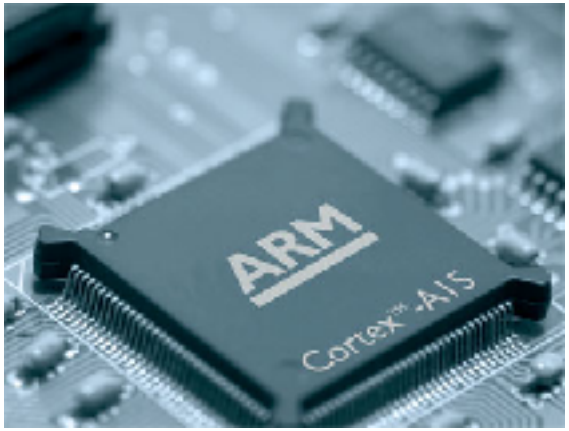
- Fuses, EPROM, or Static RAM cells are used to store the "configuration".
  - Here, it determines function implemented by LUT, selection of Flip-flop, and interconnection points.
- Many FPGAs include special circuits to accelerate adder carry-chain and many special cores: RAMs, MAC, Enet, PCI, SERDES, CPUs, ...

FPGA versus ASIC



- **ASIC:** Higher NRE costs (10's of $M). Relatively Low cost per die (10's of $ or less).
- **FPGAs:** Low NRE costs. Relatively low silicon efficiency ⇒ high cost per part (> 10's of $ to 1000's of $).
- **Cross-over volume** from cost effective FPGA design to ASIC was often in the 100K range.

Microprocessors



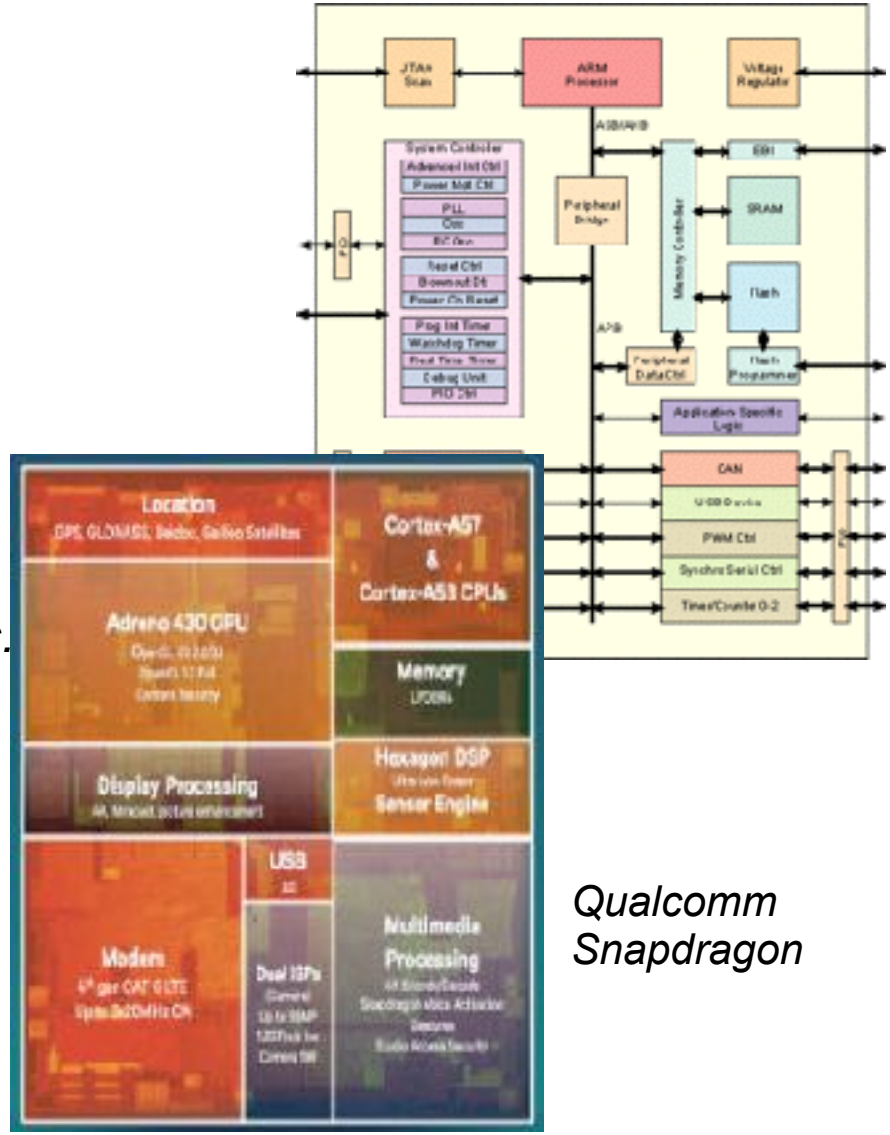
- Where relatively low performance and/or high flexibility is needed, a viable implementation alternative:
  - Software implements desired function
  - "Microcontroller", often with built in nonvolatile program memory and used as single function.
- Furthermore, instruction set processors are an "abstraction" level. Two ways:
  - Instruction Set Architecture (ISA)
  - "Synthesizable" RTL model ("soft core", available in HDL)
- Their implementation hosted on a variety of implementation platforms: standard-cell, gate-array, FPGA, other processors?

§	Assembler
	ADD{cond}{S} Rd, Rn, <Operand2>
	ADC{cond}{S} Rd, Rn, <Operand2>
5E	QADD{cond} Rd, Rm, Rn
5E	QDADD{cond} Rd, Rm, Rn
	SUB{cond}{S} Rd, Rn, <Operand2>
	SBC{cond}{S} Rd, Rn, <Operand2>
	RSB{cond}{S} Rd, Rn, <Operand2>
	RSC{cond}{S} Rd, Rn, <Operand2>
5E	QSUB{cond} Rd, Rm, Rn
5E	QDSUB{cond} Rd, Rm, Rn
2	MUL{cond}{S} Rd, Rm, Rs
2	MLA{cond}{S} Rd, Rm, Rs, Rn
M	UMULL{cond}{S} RdLo, RdHi, Rm, Rs
M	UMLAL{cond}{S} RdLo, RdHi, Rm, Rs
6	UMAAL{cond} RdLo, RdHi, Rm, Rs

System-on-chip (SOC)

- *Brings together: standard cell blocks, custom analog blocks, processor cores, memory blocks, embedded FPGAs, …*
- *Standardized on-chip buses (or hierarchical interconnect) permit "easy" integration of many blocks.*
  - *Ex: AXI, AMBA, Sonics, …*
- *"IP Block" business model: Hard- or soft-cores available from third party designers.*

- *ARM, inc. is the shining example. Hard- and "synthesizable" RISC processors.*
- *ARM and other companies provide, Ethernet, USB controllers, analog functions, memory blocks, …*



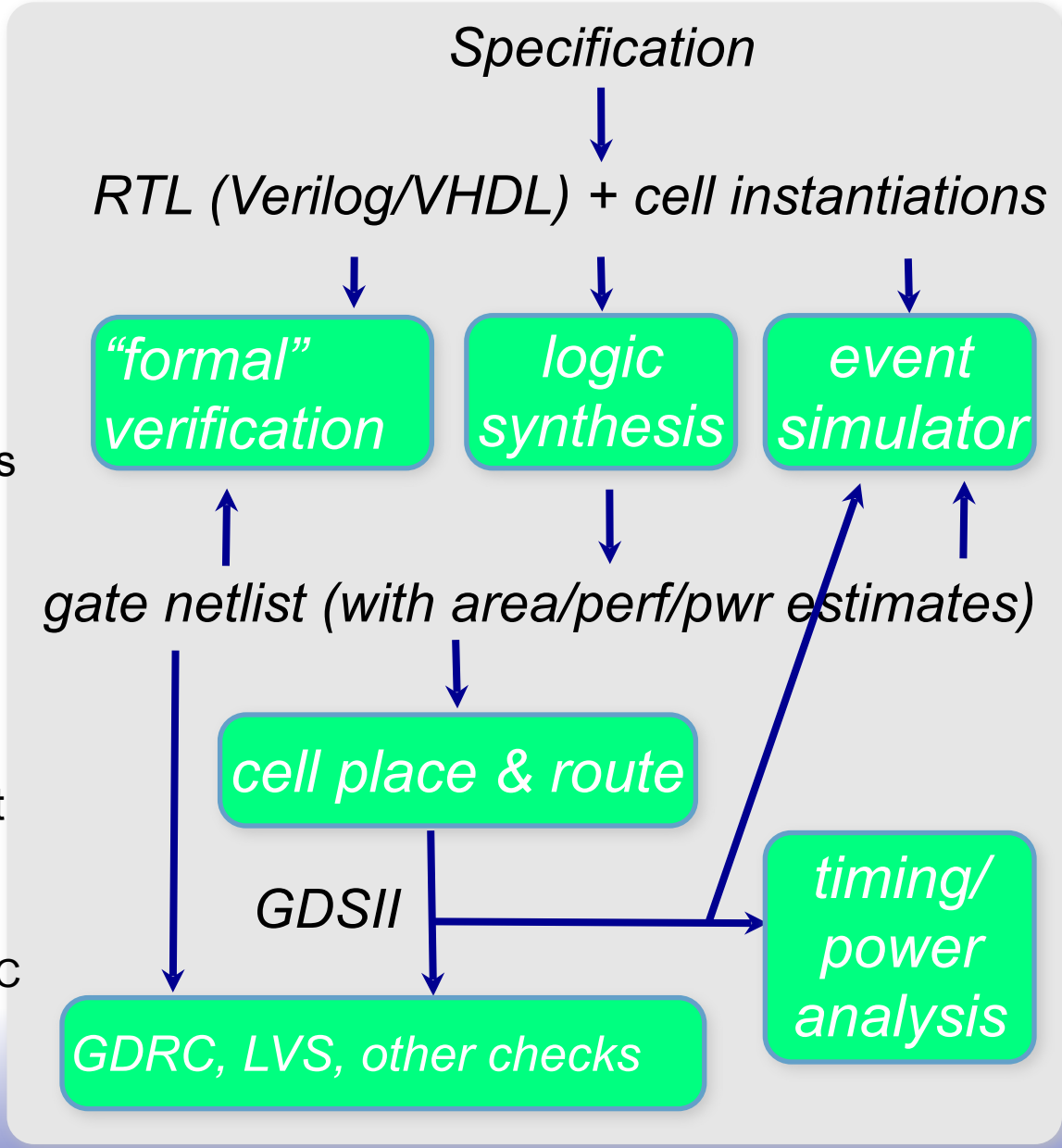
Qualcomm Snapdragon

- Pre-verified block designs, standard bus interfaces (or adapters) ease integration - lower NREs, shorten TTM.

Modern ASIC Methodology and Flow

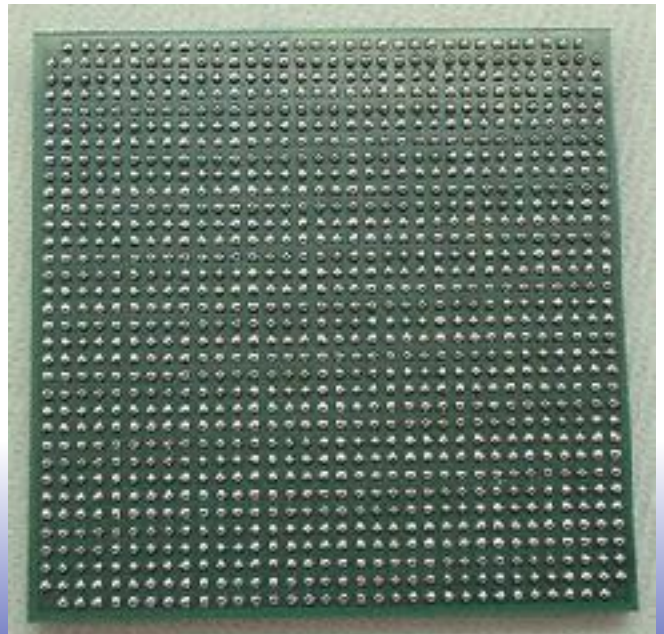
RTL Synthesis Based

- HDL specifies design as combinational logic + state elements
- Logic Synthesis converts hardware description to gate and flip-flop implementation
- Cell instantiations needed for blocks not inferred by synthesis (typically RAM)
- Event simulation verifies RTL
- "Formal" verification compares logical structure of gate netlist to RTL
- Place & route generates layout
- Timing and power checked statically
- Layout verified with LVS and GDRC

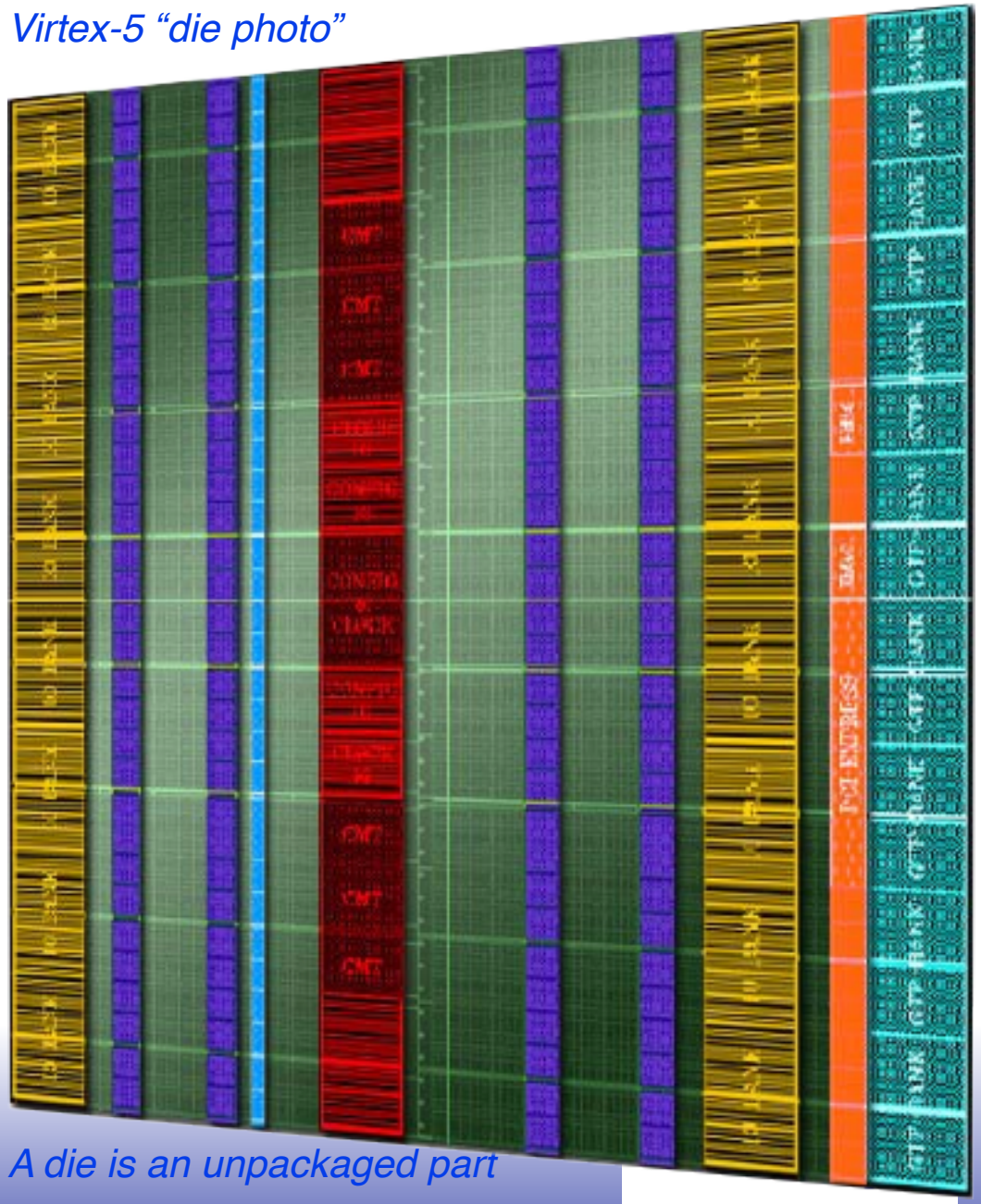


FPGAs

FPGA: Xilinx Virtex-5 XC5VLX110T



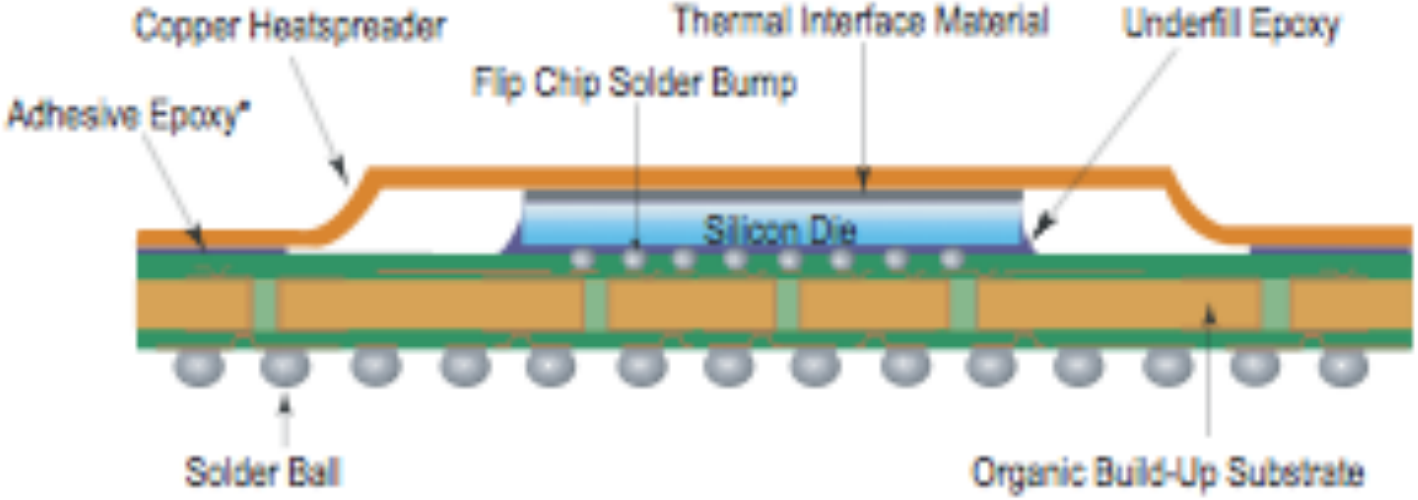
Virtex-5 "die photo"

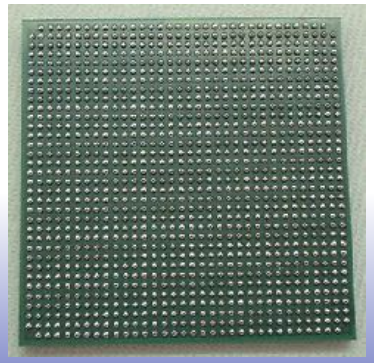


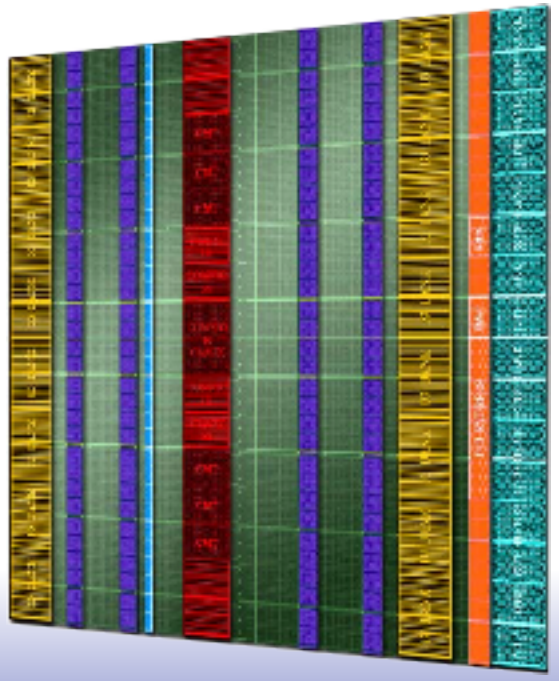
A die is an unpackaged part

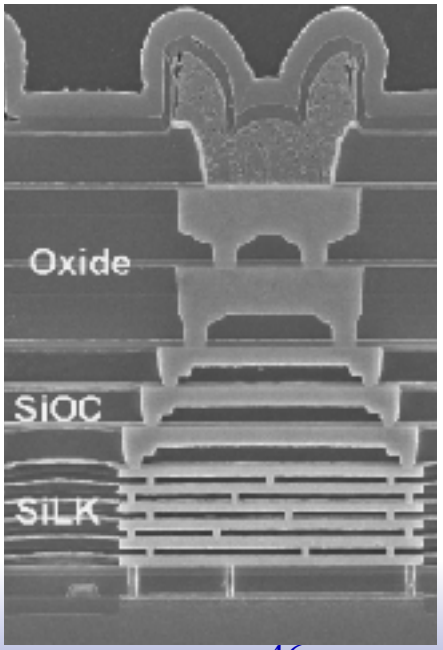
From die to PC board ...

Ball Grid Array (BGA) Flip-Chip Package



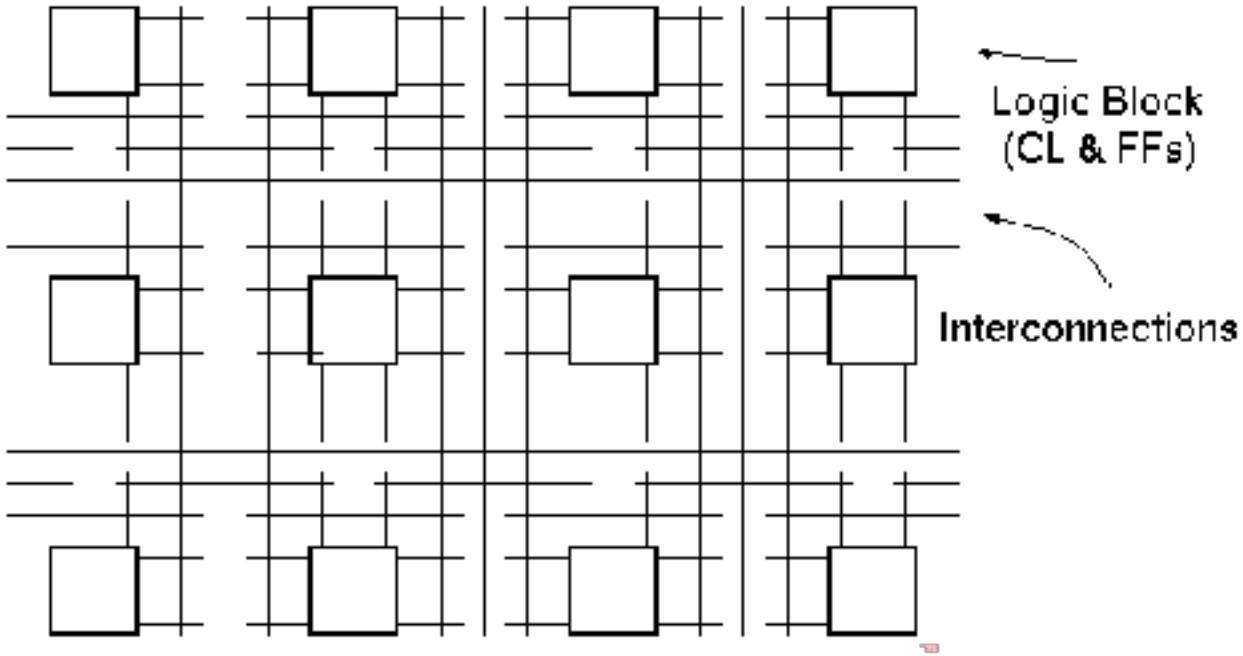






FPGA Overview

- Basic idea: two-dimensional array of logic blocks and flip-flops with a means for the user to configure (program):
  1. the interconnection between the logic blocks,
  2. the function of each block.



Simplified version of FPGA internal architecture

Why are FPGAs Interesting?

- Technical viewpoint:
  - For hardware/system-designers, like ASICs - only better: "Tape-out" new design every few minutes/hours.
  - "reconfigurability" or "reprogrammability" may offer other advantages over fixed logic?
    - In-field reprogramming? Dynamic reconfiguration? Self-modifying hardware, evolvable hardware?

Why are FPGAs Interesting?

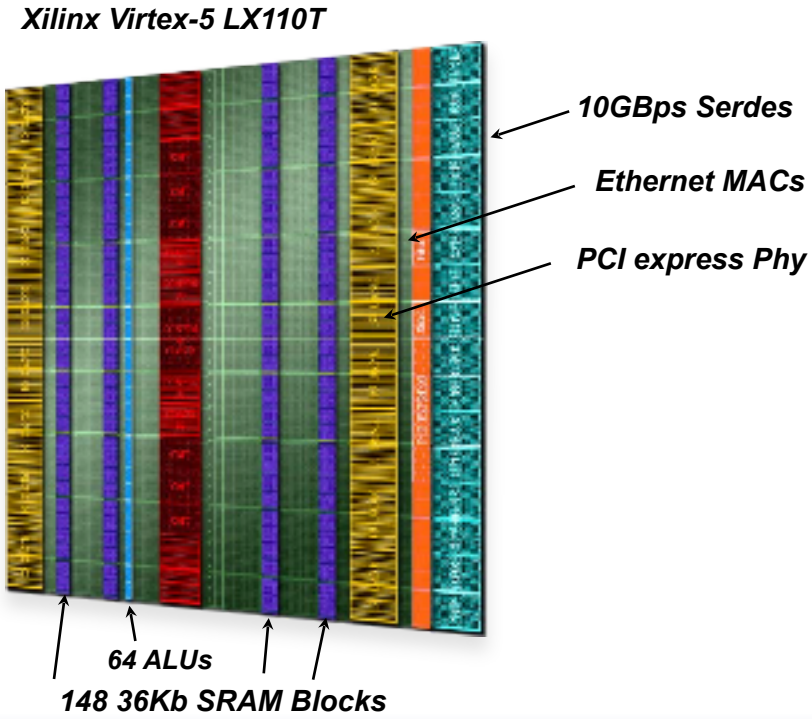
- Staggering logic capacity growth (10000x):

Year Introduced	Device	Logic Cells	"logic gate equivalents"
1985	XC2064	128	1024
2011	XC7V2000T	1,954,560	15,636,480

  - FPGAs have tracked Moore's Law better than any other programmable device.

Why are FPGAs Interesting?

- Logic capacity now only part of the story: on-chip RAM, high-speed I/Os, "hard" function blocks, ...
- Modern FPGAs are "reconfigurable systems"

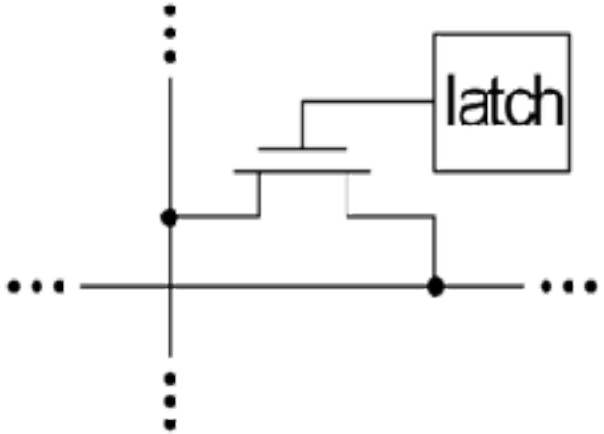


FPGAs are in widespread use

Far more designs are implemented in FPGA than in custom chips.

User Programmability

- Latch-based (Xilinx, Altera, ...)



\+ reconfigurable

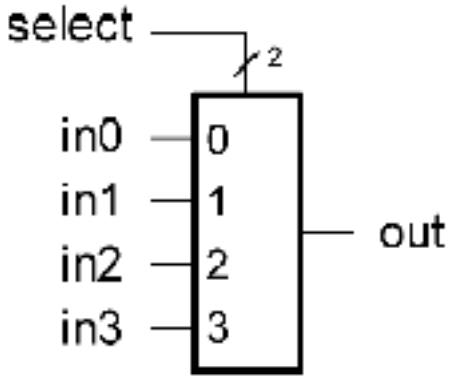
– volatile

– relatively large.

- Latches are used to:
  1. control a switch to make or break cross-point connections in the interconnect
  2. define the function of the logic blocks
  3. set user options:
     - within the logic blocks
     - in the input/output blocks
     - global reset/clock
- "Configuration bit stream" is loaded under user control

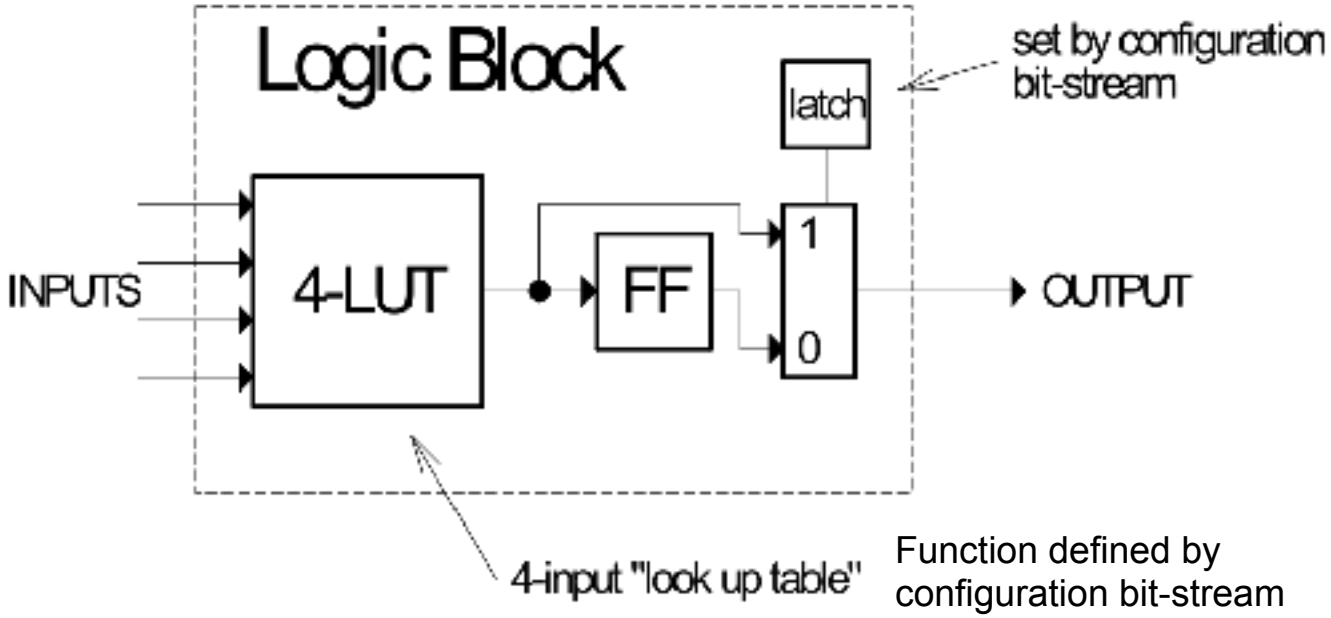
Background (review) for upcoming

- A MUX or multiplexor is a combinational logic circuit that chooses between 2^N inputs under the control of N control signals.



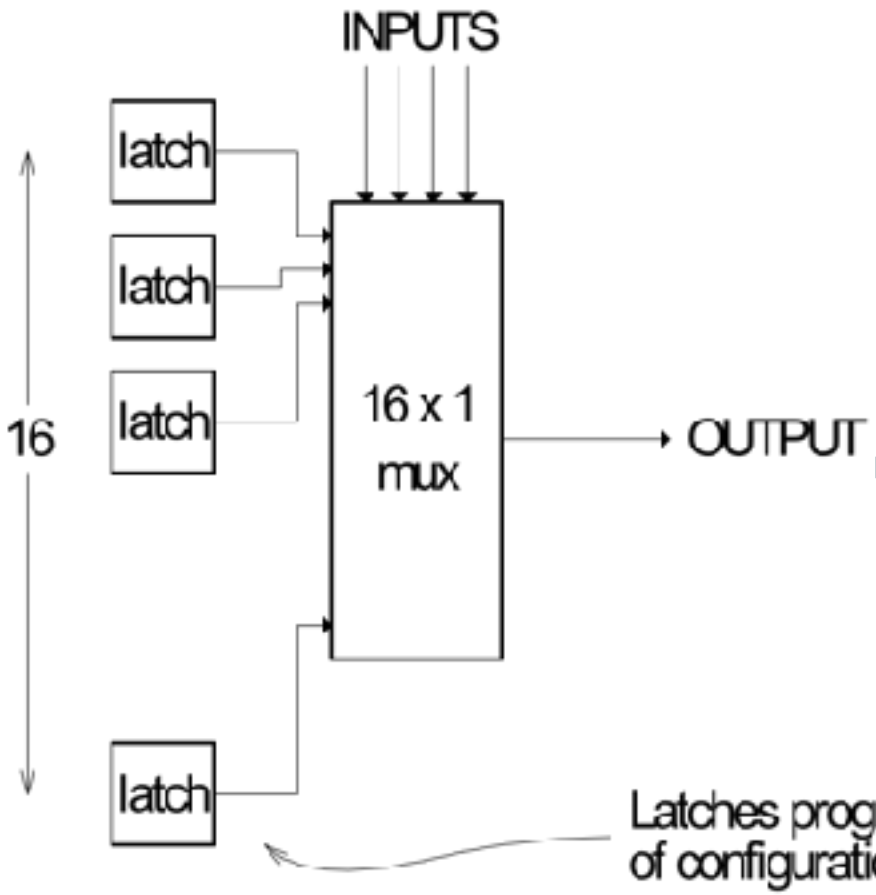
- A latch is a 1-bit memory (similar to a flip-flop).

Idealized FPGA Logic Block



- 4-input look up table (LUT)
  - implements combinational logic functions
- Register
  - optionally stores output of LUT

4-LUT Implementation



- n-bit LUT is implemented as a 2^n x 1 memory:
  - inputs choose one of 2^n memory locations.
  - memory locations (latches) are normally loaded with values from user's configuration bit stream.
  - Inputs to mux control are the CLB inputs.
- Result is a general purpose "logic gate".
  - n-LUT can implement any function of n inputs!

LUT as general logic gate

- An n-lut as a direct implementation of a function truth-table.
- Each latch location holds the value of the function corresponding to one input combination.

Example: 2-lut

INPUTS	AND	OR
00	0	0
01	0	1
10	0	1
11	1	1

• • •

Implements any function of 2 inputs.

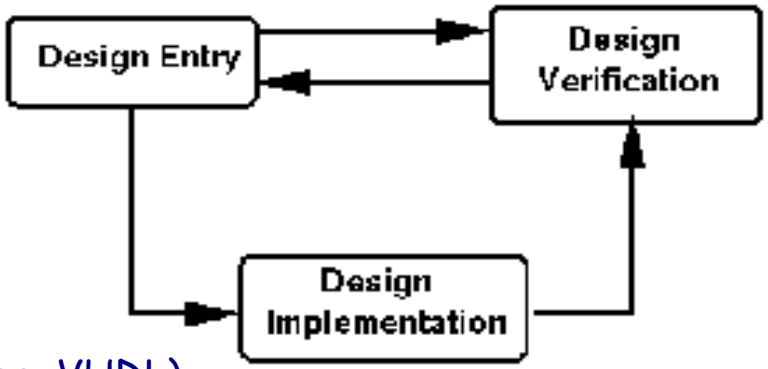
How many of these are there?

How many functions of n inputs?

Example: 4-lut

INPUTS	
0000	F(0,0,0,0) ← store in 1st latch
0001	F(0,0,0,1) ← store in 2nd latch
0010	F(0,0,1,0) ←
0011	F(0,0,1,1) ←
0011	
0100	•
0101	•
0110	•
0111	
1000	
1001	
1010	
1011	
1100	
1101	
1110	
1111	

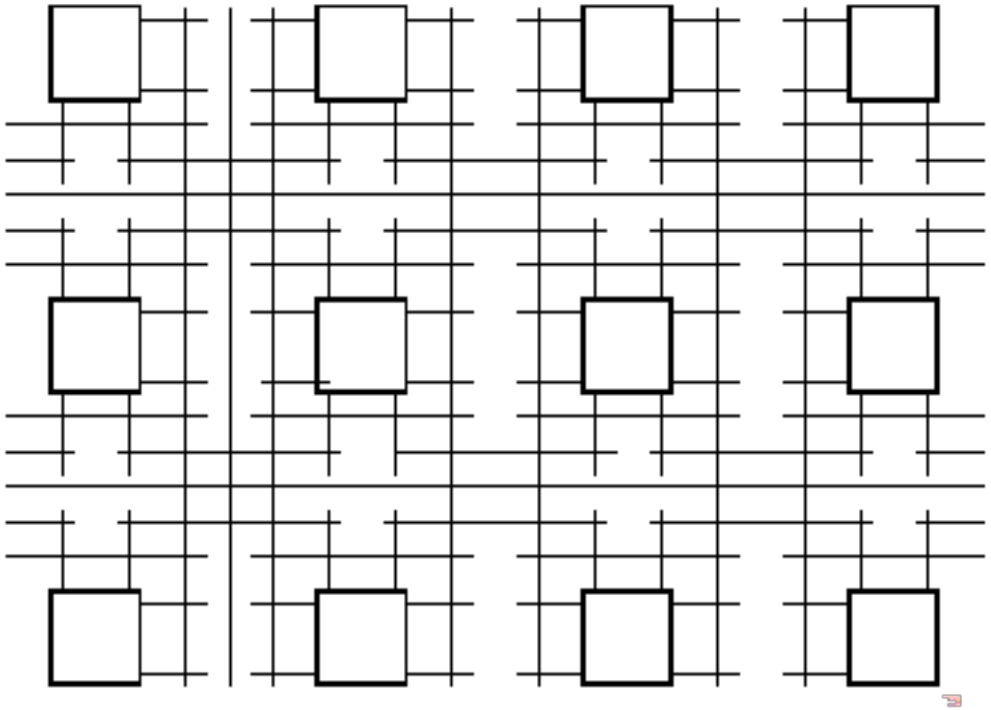
FPGA Generic Design Flow



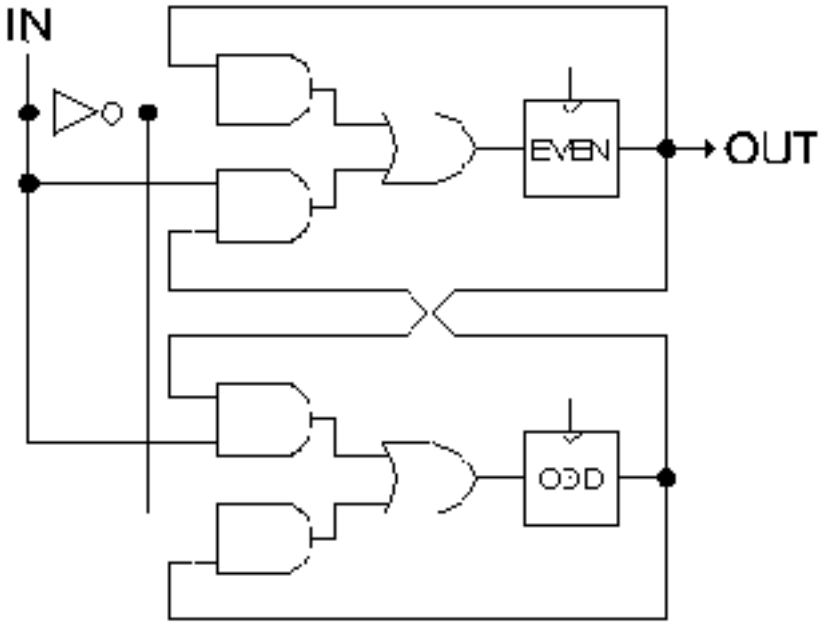
- Design Entry:
  - Create your design files using:
    - schematic editor or
    - HDL (hardware description languages: Verilog, VHDL)
- Design Implementation:
  - Logic synthesis (in case of using HDL entry) followed by,
  - Partition, place, and route to create configuration bit-stream file
- Design verification:
  - Optionally use simulator to check function,
  - Load design onto FPGA device (cable connects PC to development board), optional "logic scope" on FPGA
    - check operation at full speed in real environment.

Example Partition, Placement, and Route

- Idealized FPGA structure:



- Example Circuit:
  - collection of gates and flip-flops



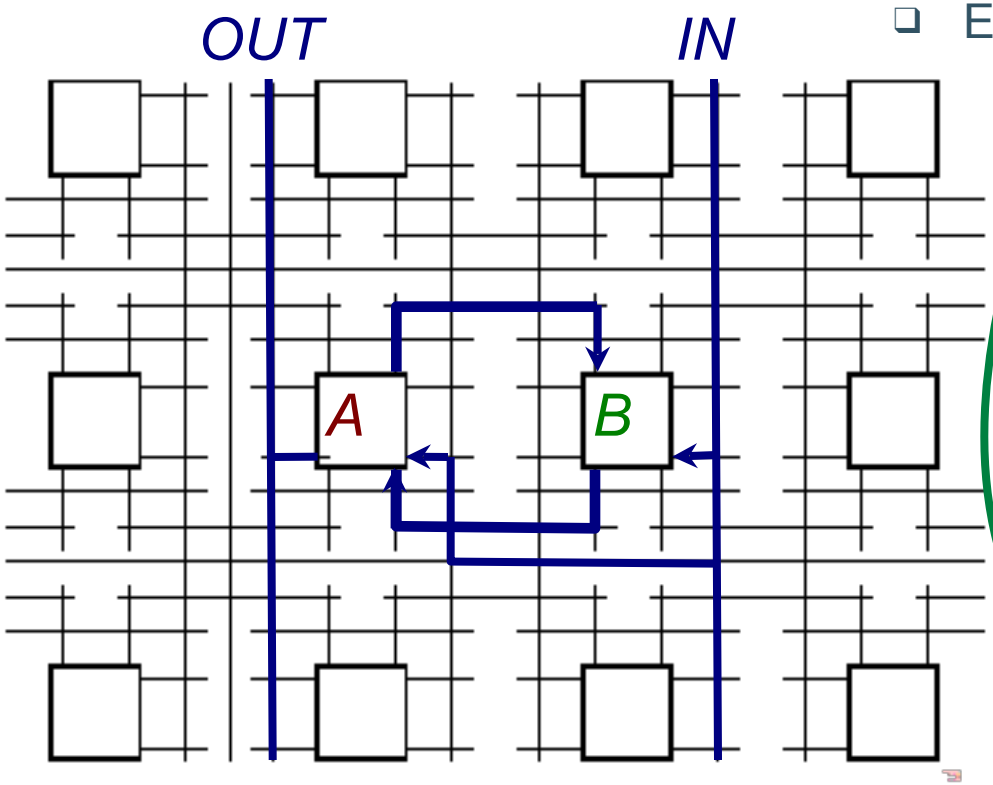
Circuit combinational logic must be "covered" by 4-input 1-output LUTs.

Flip-flops from circuit must map to FPGA flip-flops.
(Best to preserve "closeness" to CL to minimize wiring.)

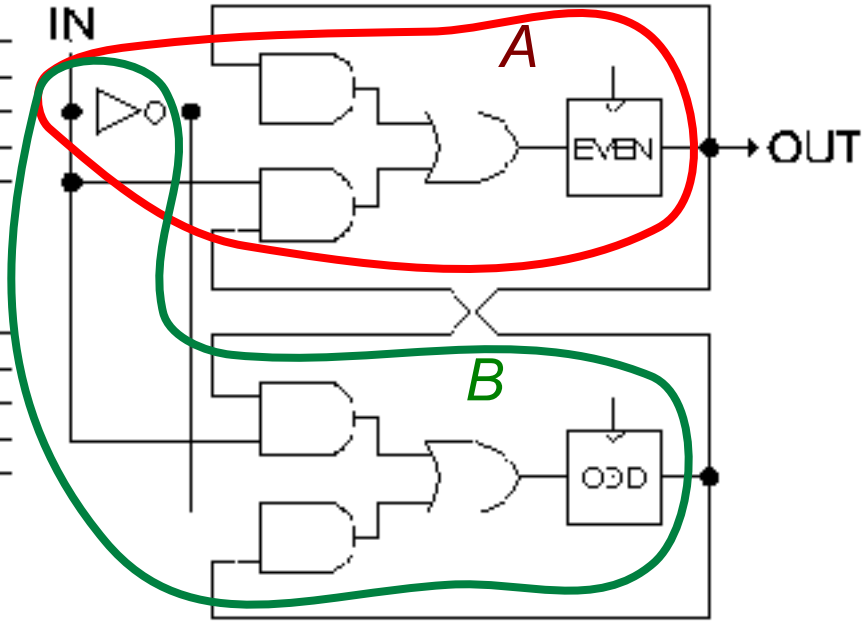
Best placement in general attempts to minimize wiring.

Vdd, GND, clock, and global resets are all "prewired".

Example Partition, Placement, and Route



- Example Circuit:
  - collection of gates and flip-flops



Two partitions. Each has single output, no more than 4 inputs, and no more than 1 flip-flop. In this case, inverter goes in both partitions.

Note: the partition can be arbitrarily large as long as it has not more than 4 inputs and 1 output, and no more than 1 flip-flop.

Xilinx FPGAs (interconnect detail)